

ADS1278-SP Radiation Hardened 8-Ch Simultaneous-Sampling 24-Bit Analog-to-Digital Converter

1 Features

- Radiation Hardened
 - TID 75 krad(Si)
 - TID Radiation Lot Acceptance Test (RLAT) TBD
 - Single Event Latchup (SEL) Immune to LET 68 MeV·cm²/mg @ 125°C
- Simultaneously Samples Eight Channels
- Up to 128-kSPS Data Rate
- AC Performance:
 - 63-kHz Bandwidth
 - 111-dB SNR (High-Resolution Mode)
 - -108-dB THD
- DC Accuracy:
 - 0.8- μ V/°C Offset Drift
 - 1.3-ppm/°C Gain Drift
- Selectable Operating Modes:
 - High-Speed: 128 kSPS, 106-dB SNR
 - High-Resolution: 52 kSPS, 111-dB SNR
 - Low-Power: 52 kSPS, 31 mW/ch
 - Low-Speed: 10 kSPS, 7 mW/ch
- Linear Phase Digital Filter
- SPI™ or Frame-Sync Serial Interface
- Low Sampling Aperture Error
- Modulator Output Option (Digital Filter Bypass)
- Analog Supply: 5 V
- Digital Core: 1.8 V
- I/O Supply: 1.8 V to 3.3 V

2 Applications

- Space Systems (Satellite, Shuttles, Stations)
 - Satellite Temperature and Position Sensing
 - Orbital Observation Systems
 - Precision and Scientific Applications
 - High-Accuracy Instrumentation

3 Description

The ADS1278-SP (octal) is a 24-bit, delta-sigma ($\Delta\Sigma$) analog-to-digital converter (ADC) with data rates up to 128k samples per second (SPS), allowing simultaneous sampling of eight channels.

Traditionally, industrial delta-sigma ADCs offering good drift performance use digital filters with large passband droop. As a result, they have limited signal bandwidth and are mostly suited for dc measurements. High-resolution ADCs in audio applications offer larger usable bandwidths, but the offset and drift specifications are significantly weaker than respective industrial counterparts. The ADS1278-SP combines these types of converters, allowing high-precision industrial measurement with excellent dc and ac specifications.

The high-order, chopper-stabilized modulator achieves very low drift with low in-band noise. The onboard decimation filter suppresses modulator and signal out-of-band noise. These ADCs provide a usable signal bandwidth up to 90% of the Nyquist rate with less than 0.005 dB of ripple.

Device Information⁽¹⁾

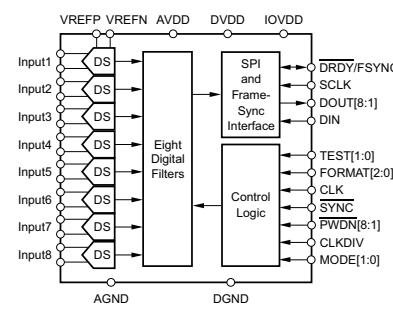
| PART NUMBER | GRADE | PACKAGE |
|-----------------|--|----------------------------------|
| ADS1278MHFQ-MLS | Flight Grade 75 krad(Si); -55°C to 125°C | 84-Pin HFQ |
| ADS1278WHFQ-MLS | Flight Grade 75 krad(Si); -55°C to 115°C | Weight: 4.46 g ⁽³⁾ |
| ADS1278HFQ/EM | Engineering Samples ⁽²⁾ | |
| ADS1278EVM-CVAL | Ceramic Evaluation Board | EVM |

(1) For all available packages, see the orderable addendum at the end of the data sheet.

(2) These units are intended for engineering evaluation only. They are processed to a noncompliant flow. These units are not suitable for qualification, production, radiation testing or flight use. Parts are not warranted for performance over the full MIL specified temperature range of -55°C to 125°C or operating life.

(3) Weight is accurate to $\pm 10\%$.

Simplified Schematic



ADS1278-SP



An IMPORTANT NOTICE at the end of this data sheet addresses availability, warranty, changes, use in safety-critical applications, intellectual property matters and other important disclaimers. PRODUCTION DATA.

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4 Revision History

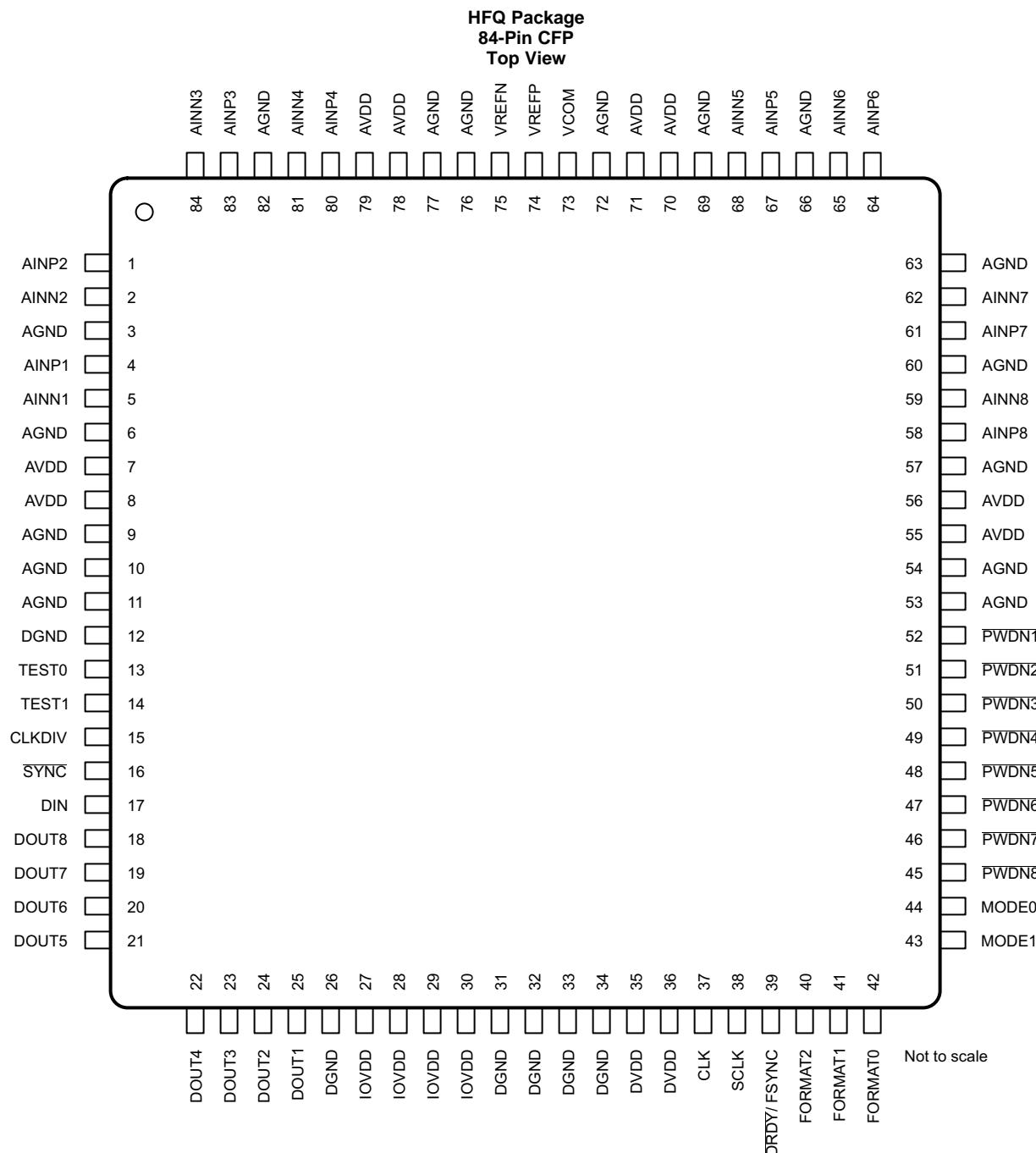
NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

| Changes from Revision A (December 2018) to Revision B | Page |
|---|------|
| • Changed Advance Information to Production Data. | 1 |

5 Description (continued)

Four operating modes allow for optimization of speed, resolution, and power. All operations are controlled directly by pins; there are no registers to program. The device is fully specified over the extended temperature range of -55°C to 125°C and is available in an 84-pin HFP package.

6 Pin Configuration and Functions



Pin Functions

| PIN | | I/O | DESCRIPTION |
|----------------|---|----------------------|--|
| NAME | NO. | | |
| AGND | 3, 6, 9, 10, 11, 53, 54, 57, 60, 63, 66, 69, 72, 76, 77, 82 | Analog ground | Analog ground; connect to DGND using a single plane. |
| AINP1 | 4 | Analog input | AINP[8:1] Positive analog input, channels 8 through 1. |
| AINP2 | 1 | Analog input | |
| AINP3 | 83 | Analog input | |
| AINP4 | 80 | Analog input | |
| AINP5 | 67 | Analog input | |
| AINP6 | 64 | Analog input | |
| AINP7 | 61 | Analog input | |
| AINP8 | 58 | Analog input | |
| AINN1 | 5 | Analog input | AINN[8:1] Negative analog input, channels 8 through 1. |
| AINN2 | 2 | Analog input | |
| AINN3 | 84 | Analog input | |
| AINN4 | 81 | Analog input | |
| AINN5 | 68 | Analog input | |
| AINN6 | 65 | Analog input | |
| AINN7 | 62 | Analog input | |
| AINN8 | 59 | Analog input | |
| AVDD | 7, 8, 55, 56, 70, 71, 78, 79 | Analog power supply | Analog power supply (4.75 V to 5.25 V). |
| VCOM | 73 | Analog output | AVDD / 2 Unbuffered voltage output. |
| VREFN | 75 | Analog input | Negative reference input. |
| VREFP | 74 | Analog input | Positive reference input. |
| CLK | 37 | Digital input | Master clock input. |
| CLKDIV | 15 | Digital input | CLK input divider control: 1 = 32.768 MHz (High-Speed mode only) / 27 MHz 0 = 13.5 MHz (low-power) / 5.4 MHz (low-speed) |
| DGND | 12, 26, 31, 32, 33, 34 | Digital ground | Digital ground power supply. |
| DIN | 17 | Digital input | Daisy-chain data input. |
| DOUT1 | 25 | Digital output | DOUT1 is TDM data output (TDM mode). DOUT[8:1] Data output for channels 8 through 1. |
| DOUT2 | 24 | Digital output | |
| DOUT3 | 23 | Digital output | |
| DOUT4 | 22 | Digital output | |
| DOUT5 | 21 | Digital output | |
| DOUT6 | 20 | Digital output | |
| DOUT7 | 19 | Digital output | |
| DOUT8 | 18 | Digital output | |
| DRDY/ FSYNC | 39 | Digital input/output | Frame-Sync protocol: frame clock input; SPI protocol: data ready output. |
| DVDD | 35, 36 | Digital power supply | Digital core power supply (+1.65 V to +1.95 V). |
| FORMAT0 | 42 | Digital input | FORMAT[2:0] Selects Frame-Sync/SPI protocol, TDM/discrete data outputs, fixed/dynamic position TDM data, and modulator mode/normal operating mode. |
| FORMAT1 | 41 | Digital input | |
| FORMAT2 | 40 | Digital input | |
| IOVDD | 27, 28, 29, 30 | Digital power supply | I/O power supply (+1.65 V to +3.6 V). |

Pin Functions (continued)

| PIN | | I/O | DESCRIPTION |
|--------------|-----|----------------------|--|
| NAME | NO. | | |
| MODE0 | 44 | Digital input | MODE[1:0] Selects High-Speed, High-Resolution, Low-Power, or Low-Speed mode operation. |
| MODE1 | 43 | Digital input | |
| <u>PWDN1</u> | 52 | Digital input | |
| <u>PWDN2</u> | 51 | Digital input | |
| <u>PWDN3</u> | 50 | Digital input | |
| <u>PWDN4</u> | 49 | Digital input | |
| <u>PWDN5</u> | 48 | Digital input | |
| <u>PWDN6</u> | 47 | Digital input | |
| <u>PWDN7</u> | 46 | Digital input | |
| <u>PWDN8</u> | 45 | Digital input | |
| SCLK | 38 | Digital input/output | Serial clock input, modulator clock output. |
| <u>SYNC</u> | 16 | Digital input | Synchronize input (all channels). |
| TEST0 | 13 | Digital input | TEST[1:0] Test mode select: 00 = Normal operation 11 = Test mode 01 = Do not use 10 = Do not use |
| TEST1 | 14 | Digital input | |

7 Specifications

7.1 Absolute Maximum Ratings

over operating free-air temperature range (unless otherwise noted)⁽¹⁾

| | | MIN | MAX | UNIT |
|---------------------------------|----------------------|------|------------|------|
| AVDD to AGND | | -0.3 | 6 | V |
| AGND to DGND | | -0.3 | 0.3 | V |
| DVDD, IOVDD to DGND | | -0.3 | 3.6 | V |
| Input current | Momentary | 100 | 10 | mA |
| | Continuous | | | |
| Analog input to AGND | | -0.3 | AVDD + 0.3 | V |
| Digital input or output to DGND | | -0.3 | DVDD + 0.3 | V |
| Junction temperature | HFQ and HKP Packages | -55 | 217 | °C |
| | D Package | -55 | 175 | |
| Storage temperature, T_{stg} | | -60 | 150 | °C |

(1) Stresses beyond those listed under *Absolute Maximum Ratings* may cause permanent damage to the device. These are stress ratings only, which do not imply functional operation of the device at these or any other conditions beyond those indicated under *Recommended Operating Conditions*. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

7.2 ESD Ratings

| | | VALUE | UNIT |
|--------------------|-------------------------|--|------|
| V _(ESD) | Electrostatic discharge | Human-body model (HBM), per ANSI/ESDA/JEDEC JS-001 ⁽¹⁾ | TBD |
| | | Charged-device model (CDM), per JEDEC specification JESD22-C101 ⁽²⁾ | TBD |

(1) JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.

(2) JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process.

7.3 Recommended Operating Conditions

over operating free-air temperature range (unless otherwise noted)

| | | MIN | NOM | MAX | UNIT |
|----------------|--------------------------------|-----------------|-----|-----|------|
| T _J | Operating junction temperature | -55 | | 125 | °C |
| | | ADS1278MHFQ-MLS | | -55 | 115 |
| | | ADS1278WHFQ-MLS | | | |

7.4 Thermal Information

| THERMAL METRIC ⁽¹⁾ | | ADS1278-SP | UNIT |
|-------------------------------|--|------------|------|
| | | HFQ (CFP) | |
| | | 84 PINS | |
| R _{θJA} | Junction-to-ambient thermal resistance | 23.7 | °C/W |
| R _{θJC(top)} | Junction-to-case (top) thermal resistance | 9.6 | °C/W |
| R _{θJB} | Junction-to-board thermal resistance | 11.5 | °C/W |
| Ψ _{JT} | Junction-to-top characterization parameter | 3.0 | °C/W |
| Ψ _{JB} | Junction-to-board characterization parameter | 10.9 | °C/W |
| R _{θJC(bot)} | Junction-to-case (bottom) thermal resistance | 7.7 | °C/W |

(1) For more information about traditional and new thermal metrics, see the [Semiconductor and IC Package Thermal Metrics](#) application report.

7.5 Electrical Characteristics

All specifications at $T_A = -55^\circ\text{C}$ to 125°C , $\text{AVDD} = 5\text{ V}$, $\text{DVDD} = 1.8\text{ V}$, $\text{IOVDD} = 3.3\text{ V}$, $f_{\text{CLK}} = 27\text{ MHz}$, $\text{VREFP} = 2.5\text{ V}$, $\text{VREFN} = 0\text{ V}$, and all channels active, unless otherwise noted.

| PARAMETER | TEST CONDITIONS | SUBGROUP (1)(2) | -55°C to +125°C (ADS1278MHFQ-MLS) | | | -55°C to +115°C (ADS1278WHFQ-MLS) | | | UNIT |
|---|--|--|--------------------------------------|----------------------|--------------|--------------------------------------|-----|----------------------|------|
| | | | MIN | TYP | MAX | MIN | TYP | MAX | |
| ANALOG INPUTS | | | | | | | | | |
| Full-scale input voltage (FSR ⁽³⁾) | $V_{\text{IN}} = (\text{AINP} - \text{AINN})$ | | | $\pm V_{\text{REF}}$ | | $\pm V_{\text{REF}}$ | | V | |
| Absolute input voltage | AINP or AINN to AGND | 1, 2, 3 | AGND – 0.1 | AVDD + 0.1 | AGND – 0.1 | AVDD + 0.1 | | V | |
| Common-mode input voltage (V_{CM}) | $V_{\text{CM}} = (\text{AINP} + \text{AINN}) / 2$ | | | 2.5 | | 2.5 | | V | |
| Differential input impedance | High-Speed mode | | | 14 | | 14 | | kΩ | |
| | High-Resolution mode | | | 14 | | 14 | | | |
| | Low-Power mode | | | 28 | | 28 | | | |
| | Low-Speed mode | | | 140 | | 140 | | | |
| DC PERFORMANCE | | | | | | | | | |
| Resolution | No missing codes | 1, 2, 3 | 24 | | 24 | | | Bits | |
| Maximum data rate (f_{DATA}) | High-Speed mode | $f_{\text{CLK}} = 32.768\text{ MHz}^{(4)}$ | | 128,000 | | 128,000 | | SPS ⁽⁵⁾ | |
| | | $f_{\text{CLK}} = 27\text{ MHz}$ | | 105,469 | | 105,469 | | | |
| | High-Resolution mode | | | 52,734 | | 52,734 | | | |
| | Low-Power mode | | | 52,734 | | 52,734 | | | |
| | Low-Speed mode | | | 10,547 | | 10,547 | | | |
| Integral nonlinearity (INL) ⁽⁶⁾ | Differential input, $V_{\text{CM}} = 2.5\text{ V}$ | 1, 2, 3 | ± 0.0003 | $\pm 0.001_2$ | ± 0.0003 | $\pm 0.001_2$ | | % FSR ⁽³⁾ | |
| Offset error | | 1, 2, 3 | 0.25 | 2 | 0.25 | 2 | | mV | |
| Offset drift | | | 0.8 | | 0.8 | | | μV/°C | |
| Gain error | | 1, 2, 3 | 0.1 | 0.5 | 0.1 | 0.5 | | % FSR | |
| Gain drift | | | 1.3 | | 1.3 | | | ppm/°C | |
| Noise | High-Speed mode | Shorted input | 1, 2, 3 | 8.5 | 23 | 8.5 | 21 | μV, rms | |
| | High-Resolution mode | Shorted input | 1, 2, 3 | 5.5 | 14 | 5.5 | 13 | | |
| | Low-Power mode | Shorted input | 1, 2, 3 | 8.5 | 23 | 8.5 | 21 | | |
| | Low-Speed mode | Shorted input | 1, 2, 3 | 8.0 | 23 | 8.0 | 21 | | |
| Common-mode rejection | $f_{\text{CM}} = 60\text{ Hz}$ | 1, 2, 3 | 90 | 108 | 90 | 108 | | dB | |
| Power-supply rejection | AVDD | $f_{\text{PS}} = 60\text{ Hz}$ | | 80 | | 80 | | dB | |
| | DVDD | | | 85 | | 85 | | | |
| | IOVDD | | | 105 | | 105 | | | |
| V_{COM} output voltage | No load | | | $\text{AVDD} / 2$ | | $\text{AVDD} / 2$ | | V | |
| AC PERFORMANCE | | | | | | | | | |
| Crosstalk | $f = 1\text{ kHz}, -0.5\text{ dBFS}^{(7)}$ | | | -107 | | -107 | | dB | |
| Signal-to-noise ratio (SNR) ⁽⁸⁾ (unweighted) | High-Speed mode | | 4, 5, 6 | 98 | 106 | 98 | 106 | dB | |
| | High-Resolution mode | $V_{\text{REF}} = 2.5\text{ V}$ | 4, 5, 6 | 101 | 110 | 101 | 110 | | |
| | | $V_{\text{REF}} = 3\text{ V}$ | | | 111 | | 111 | | |
| | Low-Power mode | | 4, 5, 6 | 98 | 106 | 98 | 106 | | |
| | Low-Speed mode | | 4, 5, 6 | 98 | 107 | 98 | 107 | | |
| Total harmonic distortion (THD) ⁽⁹⁾ | $V_{\text{IN}} = 1\text{ kHz}, -0.5\text{ dBFS}$ | 4, 5, 6 | | -108 | -96 | -108 | -96 | dB | |
| Spurious-free dynamic range | | | | 109 | | 109 | | dB | |

(1) For subgroup definitions, please see [Quality Conformance Inspection](#) table.

(2) Subgroups apply to -55°C to $+125^\circ\text{C}$ column only.

(3) FSR = full-scale range = $2 V_{\text{REF}}$.

(4) $f_{\text{CLK}} = 32.768\text{-MHz}$ max for High-Speed mode and 27-MHz max for all other modes. When $f_{\text{CLK}} > 27\text{ MHz}$, operation is limited to Frame-Sync mode and $V_{\text{REF}} \leq 2.6\text{ V}$.

(5) SPS = samples per second.

(6) Best fit method.

(7) Worst-case channel crosstalk between one or more channels.

(8) Minimum SNR is ensured by the limit of the *DC noise* specification.

(9) THD includes the first nine harmonics of the input signal; Low-Speed mode includes the first five harmonics.

Electrical Characteristics (continued)

All specifications at $T_A = -55^\circ\text{C}$ to 125°C , $\text{AVDD} = 5\text{ V}$, $\text{DVDD} = 1.8\text{ V}$, $\text{IOVDD} = 3.3\text{ V}$, $f_{\text{CLK}} = 27\text{ MHz}$, $\text{VREFP} = 2.5\text{ V}$, $\text{VREFN} = 0\text{ V}$, and all channels active, unless otherwise noted.

| PARAMETER | TEST CONDITIONS | SUBGROUP (1)(2) | -55°C to +125°C (ADS1278MHFQ-MLS) | | | -55°C to +115°C (ADS1278WHFQ-MLS) | | | UNIT | | |
|--|----------------------|--|--------------------------------------|-------------------------------|----------------------------|--------------------------------------|----------------------------|-------------------------------|------|---------------|--|
| | | | MIN | TYP | MAX | MIN | TYP | MAX | | | |
| Passband ripple | | | ± 0.005 | | | ± 0.005 | | | dB | | |
| Passband | | | 0.453 f_{DATA} | | | 0.453 f_{DATA} | | | Hz | | |
| -3-dB bandwidth | | | 0.49 f_{DATA} | | | 0.49 f_{DATA} | | | Hz | | |
| Stop band attenuation | High-Resolution mode | 4, 5, 6 | 95 | | | 95 | | | dB | | |
| | All other modes | 4, 5, 6 | 100 | | | 100 | | | dB | | |
| Stop band | High-Resolution mode | 4, 5, 6 | 0.547 f_{DATA} | 127.45 $3 f_{\text{DATA}}$ | 0.547 f_{DATA} | 127.45 $3 f_{\text{DATA}}$ | 0.547 f_{DATA} | 127.45 $3 f_{\text{DATA}}$ | Hz | | |
| | All other modes | 4, 5, 6 | 0.547 f_{DATA} | 63.453 f_{DATA} | 0.547 f_{DATA} | 63.453 f_{DATA} | 0.547 f_{DATA} | 63.453 f_{DATA} | | | |
| Group delay | High-Resolution mode | | $39/f_{\text{DATA}}$ | | | $39/f_{\text{DATA}}$ | | | s | | |
| | All other modes | | $38/f_{\text{DATA}}$ | | | $38/f_{\text{DATA}}$ | | | | | |
| Settling time (latency) | High-Resolution mode | Complete settling | $78/f_{\text{DATA}}$ | | | $78/f_{\text{DATA}}$ | | | s | | |
| | All other modes | Complete settling | $76/f_{\text{DATA}}$ | | | $76/f_{\text{DATA}}$ | | | | | |
| VOLTAGE REFERENCE INPUTS | | | | | | | | | | | |
| Reference input voltage (V_{REF}) ($V_{\text{REF}} = \text{VREFP} - \text{VREFN}$) | | $f_{\text{CLK}} = 27\text{ MHz}$ | 1, 2, 3 | 0.5 | 2.5 | 3.1 | 0.5 | 2.5 | 3.1 | V | |
| | | $f_{\text{CLK}} = 32.768\text{ MHz}^{(4)}$ | 1, 2, 3 | 0.5 | 2.5 | 2.6 | 0.5 | 2.5 | 2.6 | | |
| Negative reference input (VREFN) | | | 1, 2, 3 | AGND – 0.1 | AGND + 0.1 | AGND – 0.1 | AGND + 0.1 | AGND + 0.1 | V | | |
| Positive reference input (VREFP) | | | 1, 2, 3 | $\text{VREFN} + 0.5$ | $\text{AVDD} + 0.1$ | $\text{VREFN} + 0.5$ | $\text{AVDD} + 0.1$ | $\text{AVDD} + 0.1$ | V | | |
| Reference Input impedance | High-Speed mode | | | 0.65 | | | 0.65 | | | kΩ | |
| | High-Resolution mode | | | 0.65 | | | 0.65 | | | | |
| | Low-Power mode | | | 1.3 | | | 1.3 | | | | |
| | Low-Speed mode | | | 6.5 | | | 6.5 | | | | |
| DIGITAL INPUT/OUTPUT (IOVDD = 1.8 V to 3.6 V) | | | | | | | | | | | |
| V_{IH} | | | 4, 5, 6 | 0.7 IOVDD | IOVDD | 0.7 IOVDD | IOVDD | IOVDD | V | | |
| V_{IL} | | | 4, 5, 6 | DGND | 0.3 IOVDD | DGND | 0.3 IOVDD | IOVDD | V | | |
| V_{OH} | | $I_{\text{OH}} = 4\text{ mA}$ | 4, 5, 6 | 0.8 IOVDD | IOVDD | 0.8 IOVDD | IOVDD | IOVDD | V | | |
| V_{OL} | | $I_{\text{OL}} = 4\text{ mA}$ | 4, 5, 6 | DGND | 0.2 IOVDD | DGND | 0.2 IOVDD | IOVDD | V | | |
| Input leakage | | $0 < V_{\text{IN DIGITAL}} < \text{IOVDD}$ | 4, 5, 6 | ± 11 | | | ± 10 | | | | |
| Master clock rate (f_{CLK}) | | High-Speed mode ⁽⁴⁾ | 4, 5, 6 | 0.1 | 32.768 | 0.1 | 32.768 | 32.768 | MHz | | |
| | | Other modes | 1, 2, 3 | 0.1 | 27 | 0.1 | 27 | 27 | | | |
| POWER SUPPLY | | | | | | | | | | | |
| AVDD | | | 1, 2, 3 | 4.75 | 5 | 5.25 | 4.75 | 5 | 5.25 | V | |
| DVDD | | | 1, 2, 3 | 1.65 | 1.8 | 1.95 | 1.65 | 1.8 | 1.95 | V | |
| IOVDD | | | 1, 2, 3 | 1.65 | 3.6 | 1.65 | 3.6 | 3.6 | 3.6 | V | |
| Power-down current | AVDD | | 1, 2, 3 | 1 | | | 1 | | | μA | |
| | DVDD | | 1, 2, 3 | 1 | | | 1 | | | | |
| | IOVDD | | 1, 2, 3 | 1 | | | 1 | | | | |
| AVDD current | High-Speed mode | | 1, 2, 3 | 97 | | | 97 | | | mA | |
| | High-Resolution mode | | 1, 2, 3 | 97 | | | 97 | | | | |
| | Low-Power mode | | 1, 2, 3 | 44 | | | 44 | | | | |
| | Low-Speed mode | | 1, 2, 3 | 9 | | | 9 | | | | |

Electrical Characteristics (continued)

All specifications at $T_A = -55^\circ\text{C}$ to 125°C , $\text{AVDD} = 5\text{ V}$, $\text{DVDD} = 1.8\text{ V}$, $\text{IOVDD} = 3.3\text{ V}$, $f_{\text{CLK}} = 27\text{ MHz}$, $\text{VREFP} = 2.5\text{ V}$, $\text{VREFN} = 0\text{ V}$, and all channels active, unless otherwise noted.

| PARAMETER | TEST CONDITIONS | SUBGROUP (1)(2) | -55°C to +125°C (ADS1278MHFQ-MLS) | | | -55°C to +115°C (ADS1278WHFQ-MLS) | | | UNIT |
|-------------------|----------------------|--------------------|--------------------------------------|-------|-----|--------------------------------------|-------|-----|------|
| | | | MIN | TYP | MAX | MIN | TYP | MAX | |
| DVDD current | High-Speed mode | 1, 2, 3 | | 23 | 31 | | 23 | 30 | mA |
| | High-Resolution mode | 1, 2, 3 | | 16 | 21 | | 16 | 20 | |
| | Low-Power mode | 1, 2, 3 | | 12 | 18 | | 12 | 17 | |
| | Low-Speed mode | 1, 2, 3 | | 2.5 | 5 | | 2.5 | 4.5 | |
| IOVDD current | High-Speed mode | 1, 2, 3 | | 0.25 | 1.5 | | 0.25 | 1 | mA |
| | High-Resolution mode | 1, 2, 3 | | 0.125 | 0.8 | | 0.125 | 0.6 | |
| | Low-Power mode | 1, 2, 3 | | 0.125 | 0.8 | | 0.125 | 0.6 | |
| | Low-Speed mode | 1, 2, 3 | | 0.035 | 0.5 | | 0.035 | 0.3 | |
| Power dissipation | High-Speed mode | 1, 2, 3 | | 530 | 805 | | 530 | 785 | mW |
| | High-Resolution mode | 1, 2, 3 | | 515 | 785 | | 515 | 765 | |
| | Low-Power mode | 1, 2, 3 | | 245 | 370 | | 245 | 355 | |
| | Low-Speed mode | 1, 2, 3 | | 50 | 85 | | 50 | 80 | |

7.6 Timing Requirements: SPI Format⁽¹⁾

For $T_A = -55^\circ\text{C}$ to 125°C , $\text{IOVDD} = 1.65\text{ V}$ to 3.6 V , and $\text{DVDD} = 1.65\text{ V}$ to 1.95 V .

| SYMBOL | PARAMETER | MIN | TYP | MAX | UNIT |
|----------------------------|--|-----|-----|--------|------------------|
| t_{CLK} | CLK period ($1 / f_{\text{CLK}}$) ⁽²⁾ | 37 | | 10,000 | ns |
| t_{CPW} | CLK positive or negative pulse width | 15 | | | ns |
| t_{CONV} | Conversion period ($1 / f_{\text{DATA}}$) ⁽³⁾ | 256 | | 2560 | t_{CLK} |
| $t_{\text{CD}}^{(4)}$ | Falling edge of CLK to falling edge of $\overline{\text{DRDY}}$ | | 22 | | ns |
| $t_{\text{DS}}^{(4)}$ | Falling edge of $\overline{\text{DRDY}}$ to rising edge of first SCLK to retrieve data | 1 | | | t_{CLK} |
| t_{MSBPD} | $\overline{\text{DRDY}}$ falling edge to DOUT MSB valid (propagation delay) | | | 16 | ns |
| $t_{\text{SD}}^{(4)}$ | Falling edge of SCLK to rising edge of $\overline{\text{DRDY}}$ | | 18 | | ns |
| $t_{\text{SCLK}}^{(5)}$ | SCLK period | 1 | | | t_{CLK} |
| t_{SPW} | SCLK positive or negative pulse width | 0.4 | | | t_{CLK} |
| $t_{\text{DOHD}}^{(4)(6)}$ | SCLK falling edge to new DOUT invalid (hold time) | 10 | | | ns |
| $t_{\text{DOPD}}^{(4)}$ | SCLK falling edge to new DOUT valid (propagation delay) | | | 32 | ns |
| t_{DIST} | New DIN valid to falling edge of SCLK (setup time) | 6 | | | ns |
| $t_{\text{DIHD}}^{(6)}$ | Old DIN valid to falling edge of SCLK (hold time) | 6 | | | ns |

(1) Timing parameters are characterized or assured by design for specified temperature but not production tested.

(2) $f_{\text{CLK}} = 27\text{-MHz}$ maximum.

(3) Depends on MODE[1:0] and CLKDIV selection. See Table 5 ($f_{\text{CLK}} / f_{\text{DATA}}$).

(4) Load on $\overline{\text{DRDY}}$ and DOUT = 20 pF.

(5) For best performance, limit $f_{\text{SCLK}} / f_{\text{CLK}}$ to ratios of 1, 1/2, 1/4, 1/8, etc..

(6) t_{DOHD} (DOUT hold time) and t_{DIHD} (DIN hold time) are specified under opposite worst-case conditions (digital supply voltage and ambient temperature). Under equal conditions, with DOUT connected directly to DIN, the timing margin is > 4 ns.

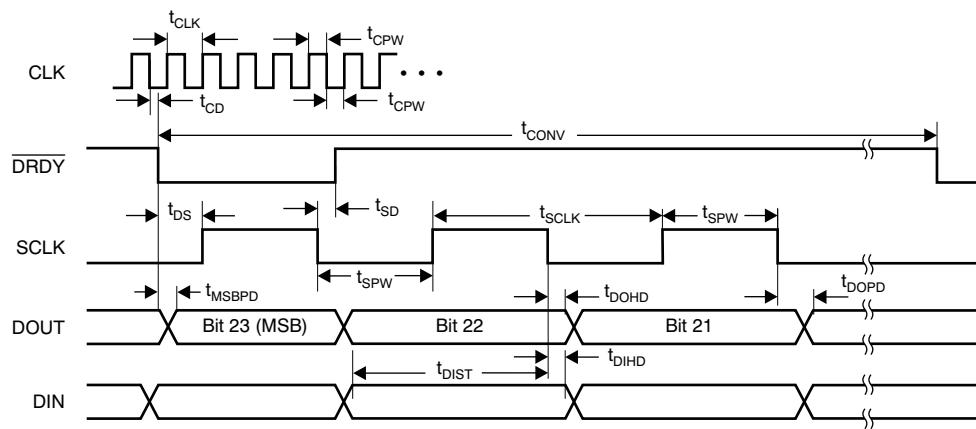


Figure 1. SPI Format Timing Characteristics

7.7 Timing Requirements: Frame-Sync Format⁽¹⁾

over operating free-air temperature range (unless otherwise noted)

| SYMBOL | PARAMETER | MIN | TYP | MAX | UNIT |
|---|---|-------|--------|------|------------|
| t_{CLK} | CLK period (1 / f_{CLK}) | 37 | 10,000 | | ns |
| | High-Speed mode only | 30.5 | | | ns |
| t_{CPW} | CLK positive or negative pulse width | 12 | | | ns |
| t_{CS} | Falling edge of CLK to falling edge of SCLK | -0.25 | 0.25 | 0.25 | t_{CLK} |
| t_{FRAME} | Frame period (1 / f_{DATA}) ⁽²⁾ | 256 | 2560 | | t_{CLK} |
| t_{FPW} | FSYNC positive or negative pulse width | 1 | | | t_{SCLK} |
| t_{FS} | Rising edge of FSYNC to rising edge of SCLK | 5 | | | ns |
| t_{SF} | Rising edge of SCLK to rising edge of FSYNC | 5 | | | ns |
| t_{SCLK} | SCLK period ⁽³⁾ | 1 | | | t_{CLK} |
| t_{SPW} | SCLK positive or negative pulse width | 0.4 | | | t_{CLK} |
| t_{DOHD} ⁽⁴⁾ ⁽⁵⁾ | SCLK falling edge to old DOUT invalid (hold time) | 10 | | | ns |
| t_{DOPD} ⁽⁵⁾ | SCLK falling edge to new DOUT valid (propagation delay) | | 31 | | ns |
| t_{MSBPD} | FSYNC rising edge to DOUT MSB valid (propagation delay) | | 31 | | ns |
| t_{DIST} | New DIN valid to falling edge of SCLK (setup time) | 6 | | | ns |
| t_{DIHD} ⁽⁴⁾ | Old DIN valid to falling edge of SCLK (hold time) | 6 | | | ns |

(1) Timing parameters are characterized or assured by design for specified temperature but not production tested.

(2) Depends on MODE[1:0] and CLKDIV selection. See [Table 5](#) (f_{CLK} / f_{DATA}).

(3) SCLK must be continuously running and limited to ratios of 1, 1/2, 1/4, and 1/8 of f_{CLK} .

(4) t_{DOHD} (DOUT hold time) and t_{DIHD} (DIN hold time) are specified under opposite worst-case conditions (digital supply voltage and ambient temperature). Under equal conditions, with DOUT connected directly to DIN, the timing margin is > 4 ns.

(5) Load on DOUT = 20 pF.

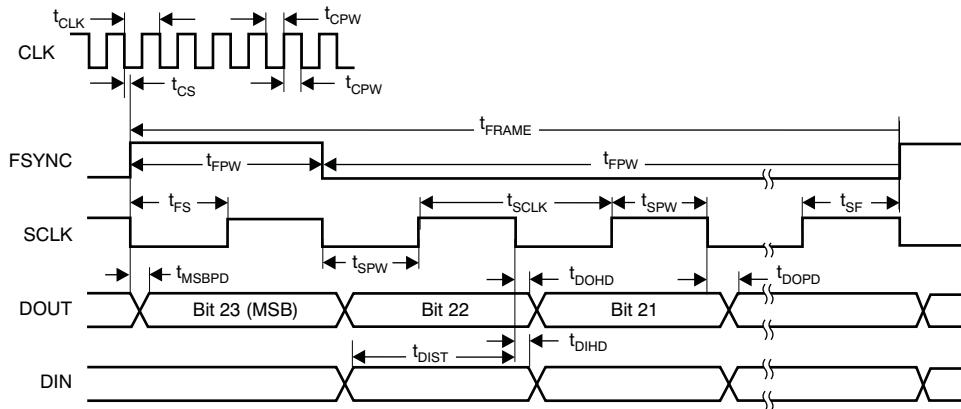


Figure 2. Frame-Sync Format Timing Characteristics

7.8 Quality Conformance Inspection

MIL-STD-883, Method 5005 - Group A

| SUBGROUP | DESCRIPTION | TEMP (°C) |
|----------|---------------------|-----------|
| 1 | Static tests at | 25 |
| 2 | Static tests at | 125 |
| 3 | Static tests at | -55 |
| 4 | Dynamic tests at | 25 |
| 5 | Dynamic tests at | 125 |
| 6 | Dynamic tests at | -55 |
| 7 | Functional tests at | 25 |

Quality Conformance Inspection (continued)

| SUBGROUP | DESCRIPTION | TEMP (°C) |
|----------|---------------------|-----------|
| 8A | Functional tests at | 125 |
| 8B | Functional tests at | –55 |
| 9 | Switching tests at | 25 |
| 10 | Switching tests at | 125 |
| 11 | Switching tests at | –55 |
| 12 | Setting time at | 25 |
| 13 | Setting time at | 125 |
| 14 | Setting time at | –55 |

7.9 Typical Characteristics

At $T_A = 25^\circ\text{C}$, High-Speed mode, AVDD = 5 V, DVDD = 1.8 V, IOVDD = 3.3 V, $f_{\text{CLK}} = 27\text{ MHz}$, VREFP = 2.5 V, and VREFN = 0 V, unless otherwise noted.

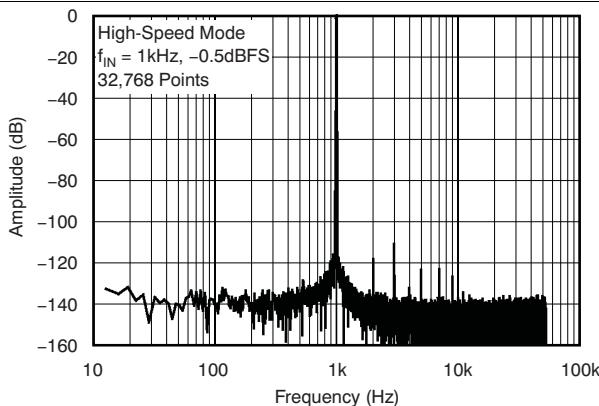


Figure 3. Output Spectrum

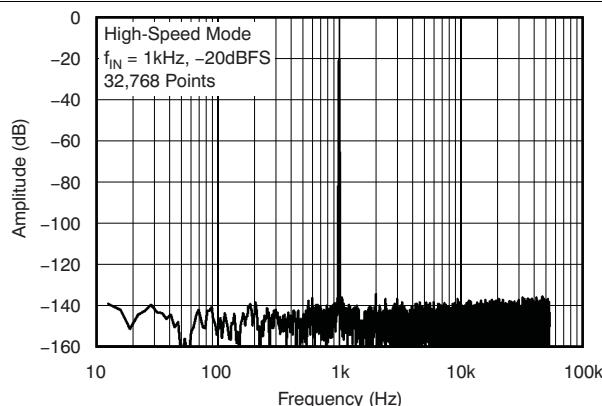


Figure 4. Output Spectrum

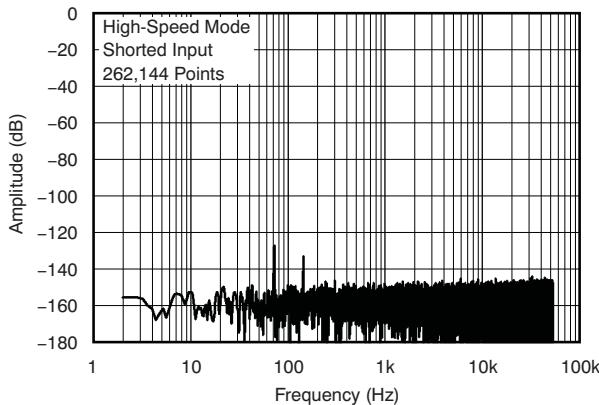


Figure 5. Output Spectrum

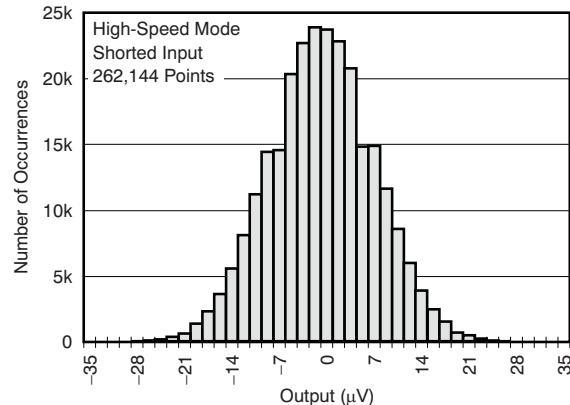


Figure 6. Noise Histogram

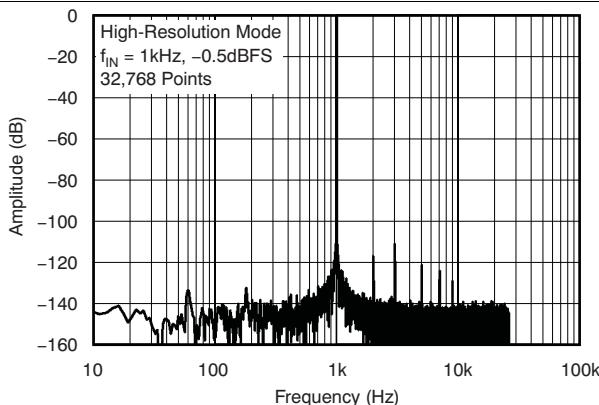


Figure 7. Output Spectrum

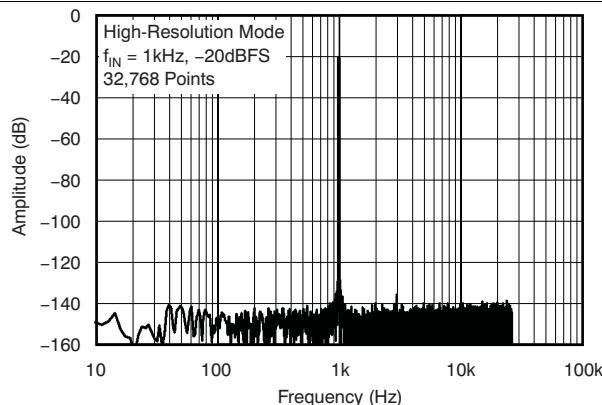
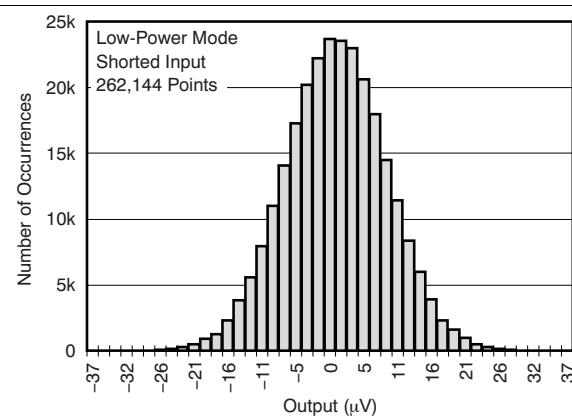
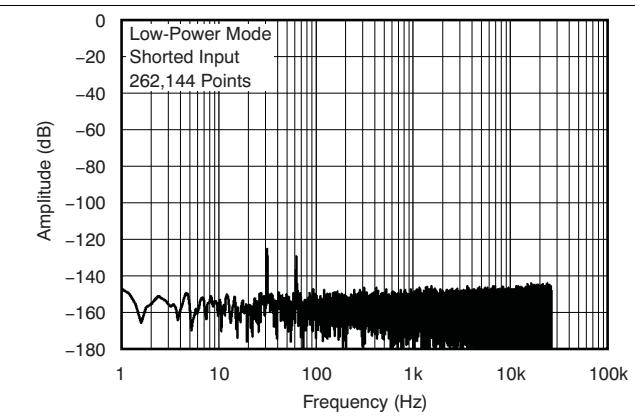
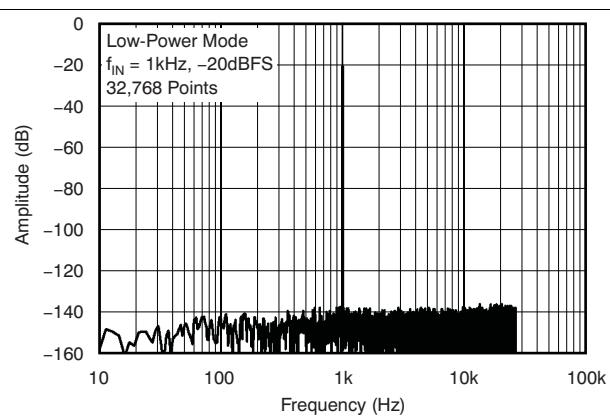
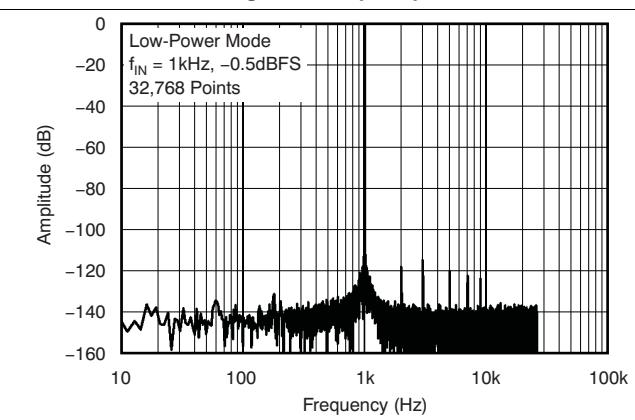
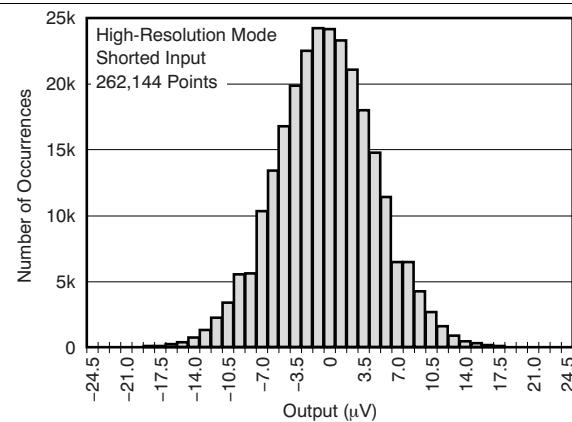
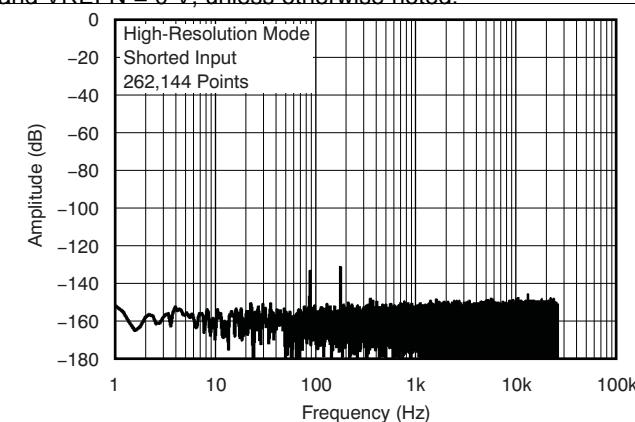


Figure 8. Output Spectrum

Typical Characteristics (continued)

At $T_A = 25^\circ\text{C}$, High-Speed mode, AVDD = 5 V, DVDD = 1.8 V, IOVDD = 3.3 V, $f_{\text{CLK}} = 27$ MHz, VREFP = 2.5 V, and VREFN = 0 V, unless otherwise noted.



Typical Characteristics (continued)

At $T_A = 25^\circ\text{C}$, High-Speed mode, AVDD = 5 V, DVDD = 1.8 V, IOVDD = 3.3 V, $f_{\text{CLK}} = 27$ MHz, VREFP = 2.5 V, and VREFN = 0 V, unless otherwise noted.

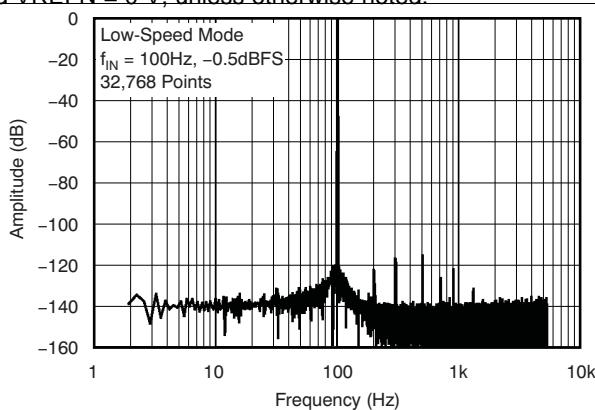


Figure 15. Output Spectrum

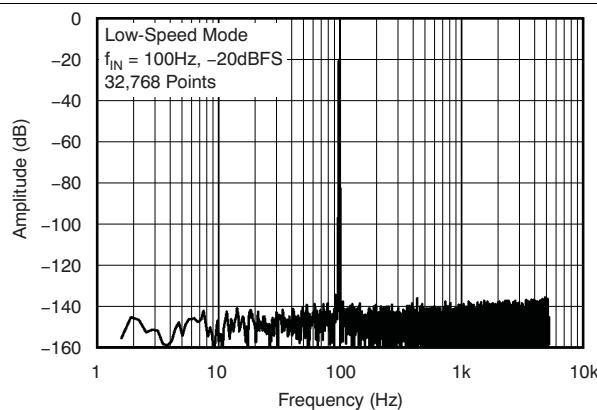


Figure 16. Output Spectrum

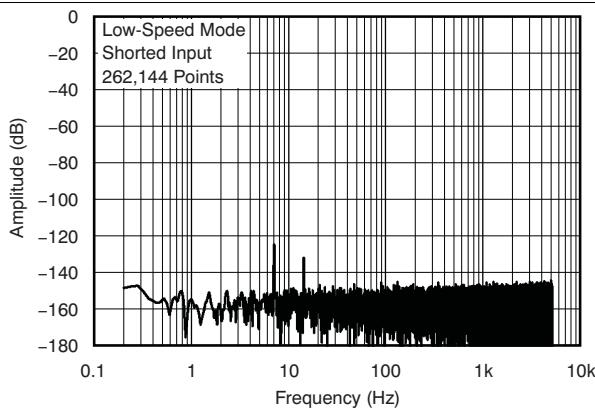


Figure 17. Output Spectrum

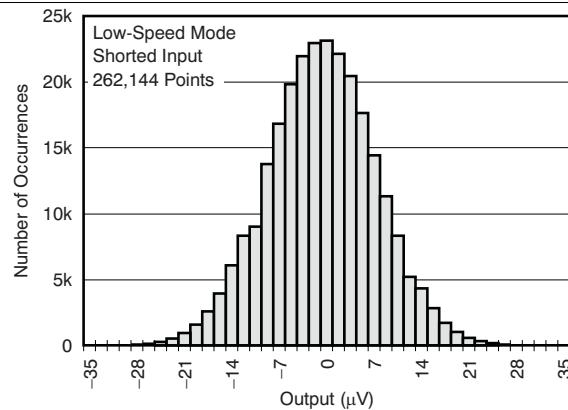


Figure 18. Noise Histogram

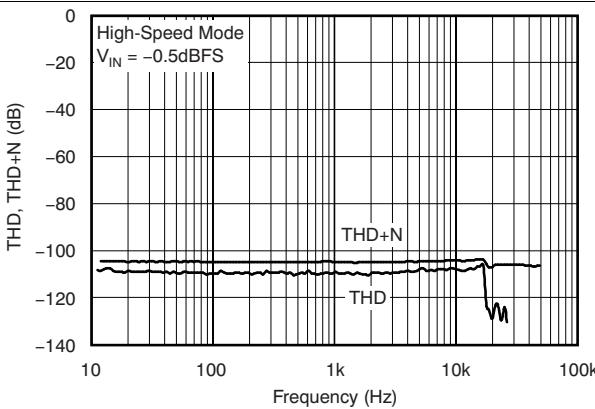


Figure 19. Total Harmonic Distortion vs Frequency

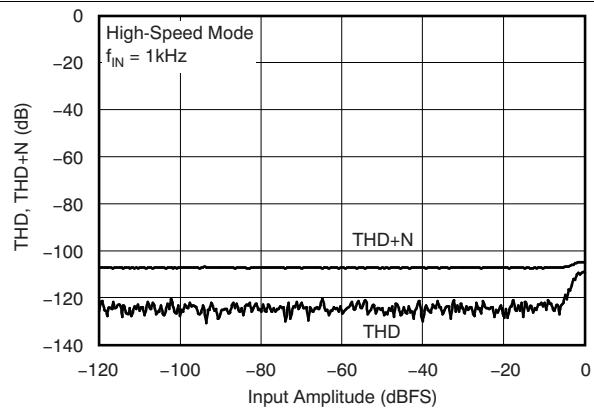


Figure 20. Total Harmonic Distortion vs Input Amplitude

Typical Characteristics (continued)

At $T_A = 25^\circ\text{C}$, High-Speed mode, AVDD = 5 V, DVDD = 1.8 V, IOVDD = 3.3 V, $f_{\text{CLK}} = 27 \text{ MHz}$, VREFP = 2.5 V, and VREFN = 0 V, unless otherwise noted.

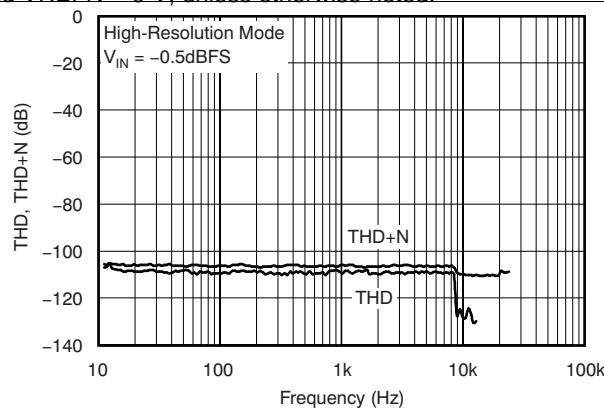


Figure 21. Total Harmonic Distortion vs Frequency

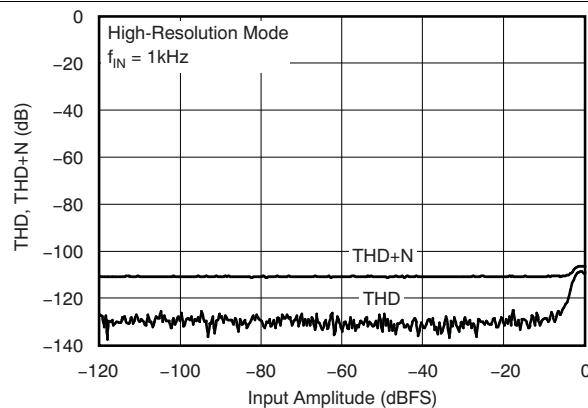


Figure 22. Total Harmonic Distortion vs Input Amplitude

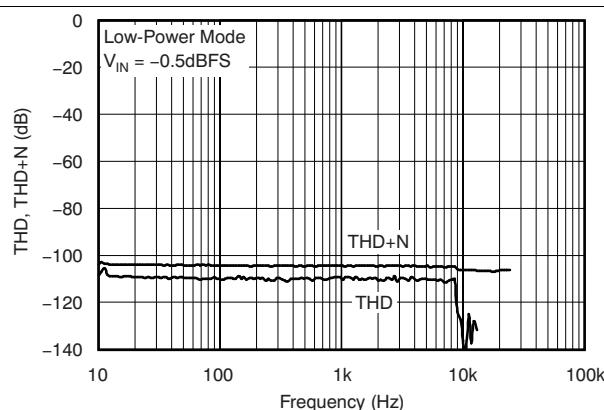


Figure 23. Total Harmonic Distortion vs Frequency

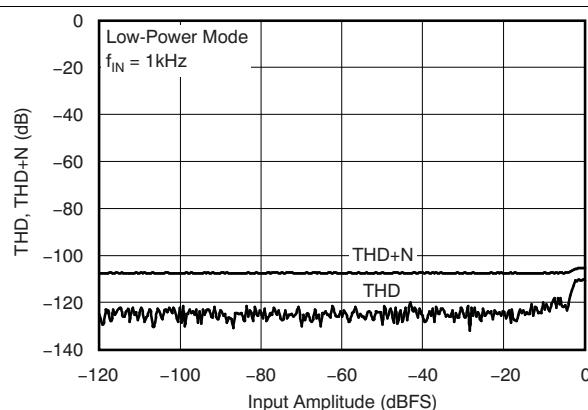


Figure 24. Total Harmonic Distortion vs Input Amplitude

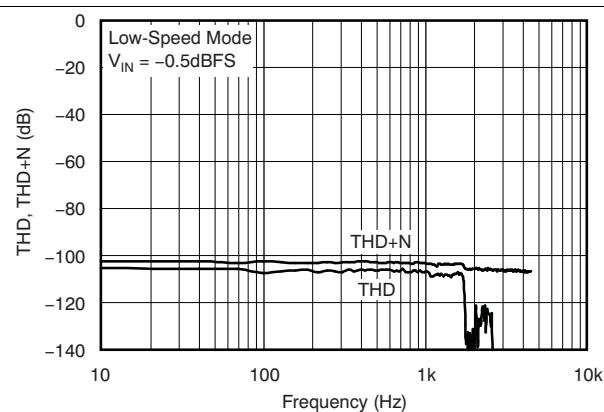


Figure 25. Total Harmonic Distortion vs Frequency

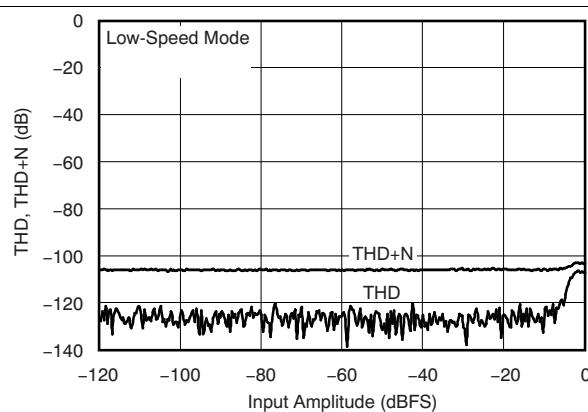


Figure 26. Total Harmonic Distortion vs Input Amplitude

Typical Characteristics (continued)

At $T_A = 25^\circ\text{C}$, High-Speed mode, AVDD = 5 V, DVDD = 1.8 V, IOVDD = 3.3 V, $f_{\text{CLK}} = 27$ MHz, VREFP = 2.5 V, and VREFN = 0 V, unless otherwise noted.

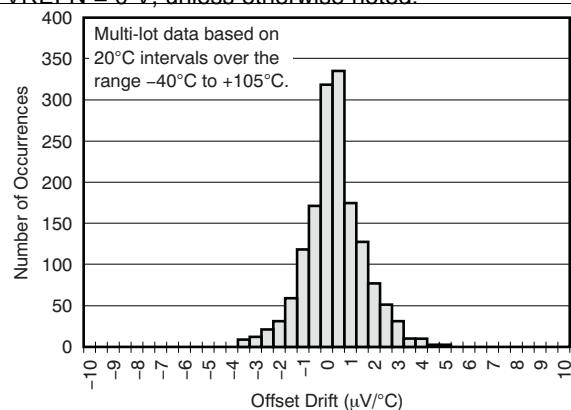


Figure 27. Offset Drift Histogram

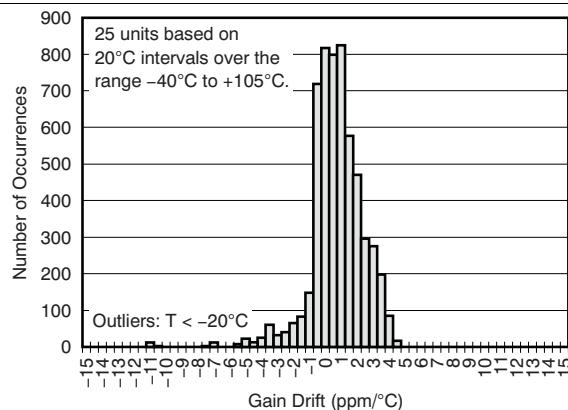


Figure 28. Gain Drift Histogram

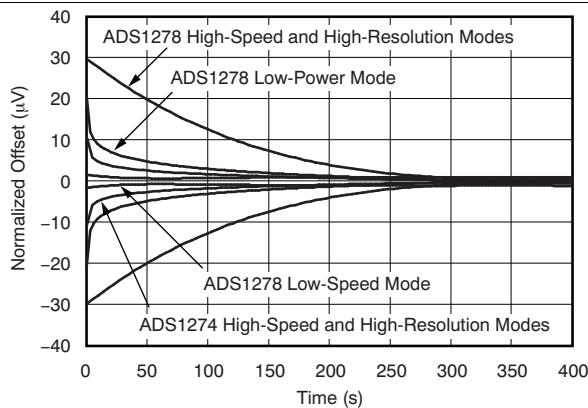


Figure 29. Offset Warmup Drift Response Band

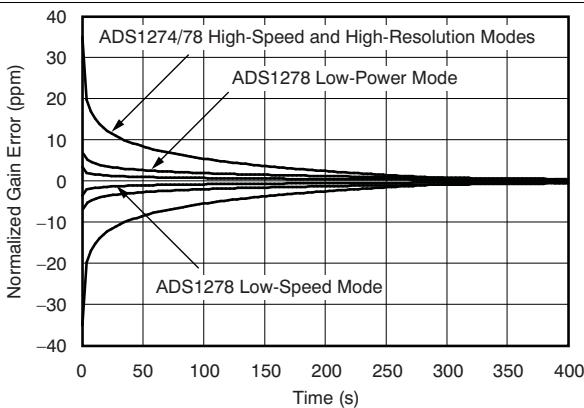


Figure 30. Gain Warmup Drift Response Band

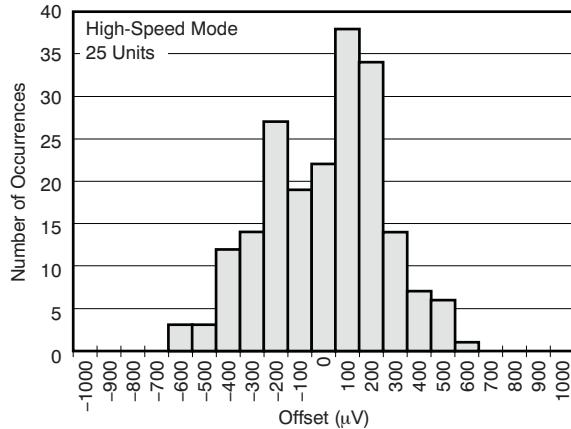


Figure 31. Offset Error Histogram

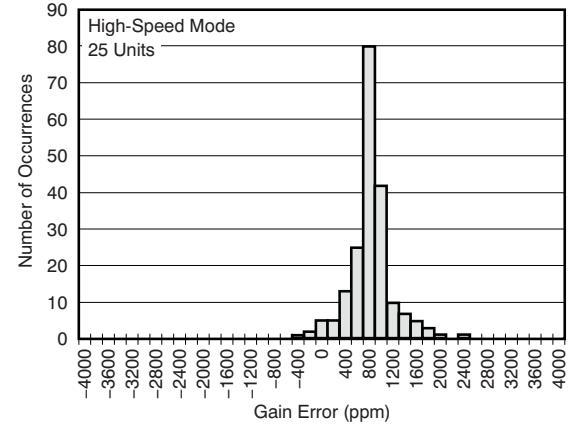


Figure 32. Gain Error Histogram

Typical Characteristics (continued)

At $T_A = 25^\circ\text{C}$, High-Speed mode, AVDD = 5 V, DVDD = 1.8 V, IOVDD = 3.3 V, $f_{\text{CLK}} = 27$ MHz, VREFP = 2.5 V, and VREFN = 0 V, unless otherwise noted.

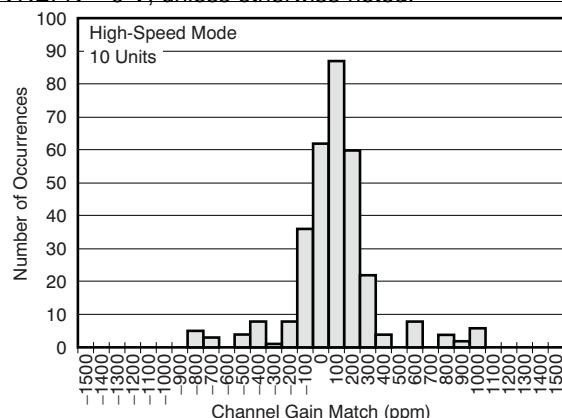


Figure 33. Channel Gain Match Histogram

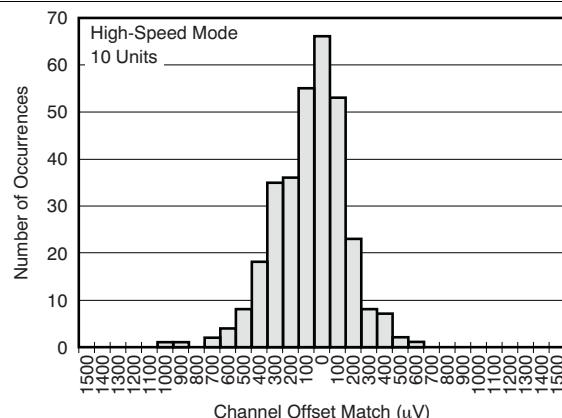


Figure 34. Channel Offset Match Histogram

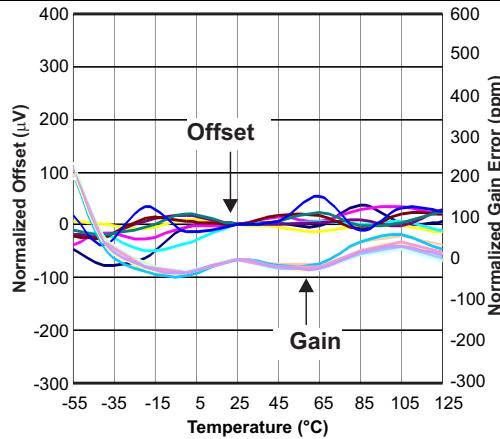


Figure 35. Offset and Gain vs Temperature

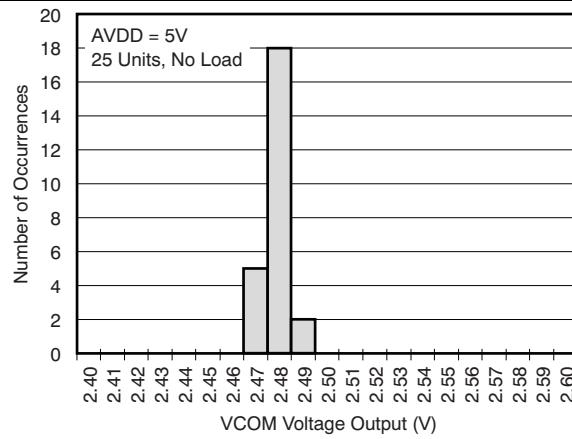


Figure 36. VCOM Voltage Output Histogram

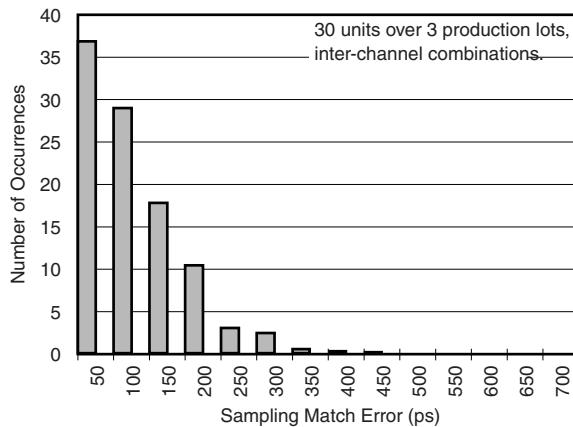


Figure 37. Sampling Match Error Histogram

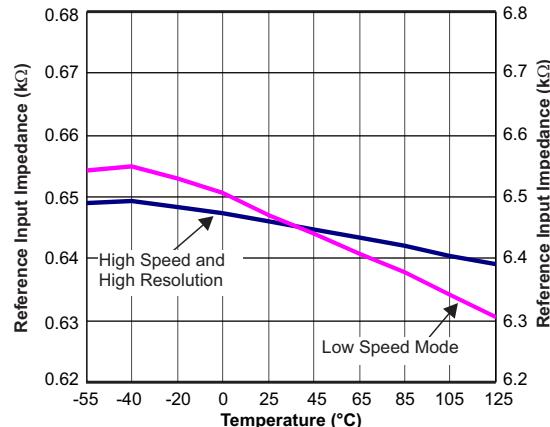
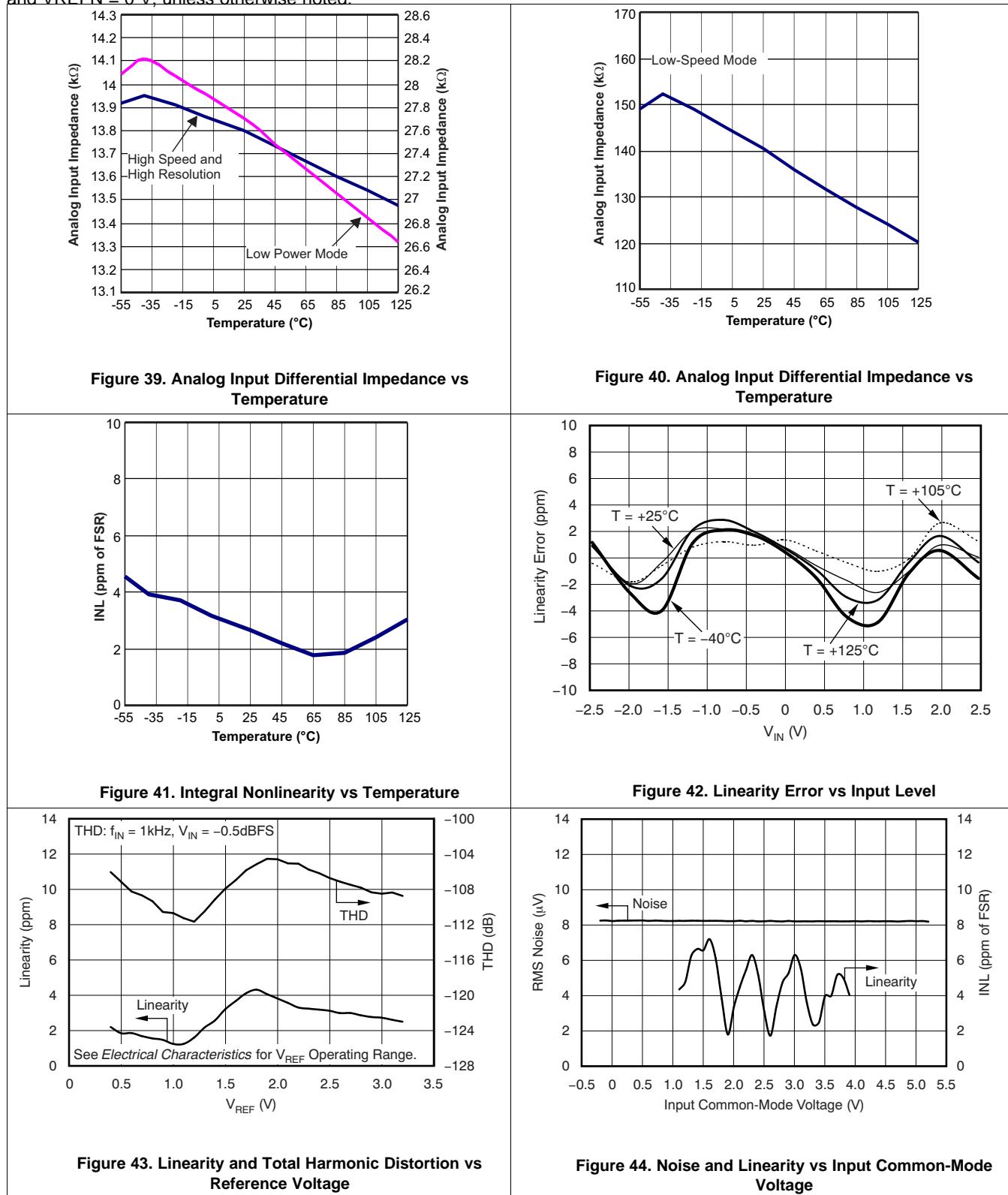


Figure 38. Reference Input Differential Impedance vs Temperature

Typical Characteristics (continued)

At $T_A = 25^\circ\text{C}$, High-Speed mode, AVDD = 5 V, DVDD = 1.8 V, IOVDD = 3.3 V, $f_{\text{CLK}} = 27$ MHz, VREFP = 2.5 V, and VREFN = 0 V, unless otherwise noted.



Typical Characteristics (continued)

At $T_A = 25^\circ\text{C}$, High-Speed mode, AVDD = 5 V, DVDD = 1.8 V, IOVDD = 3.3 V, $f_{\text{CLK}} = 27 \text{ MHz}$, VREFP = 2.5 V, and VREFN = 0 V, unless otherwise noted.

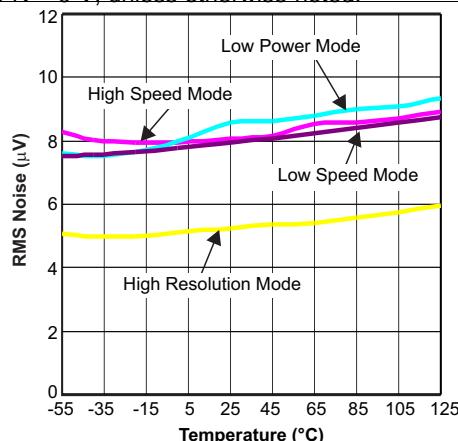


Figure 45. Noise vs Temperature

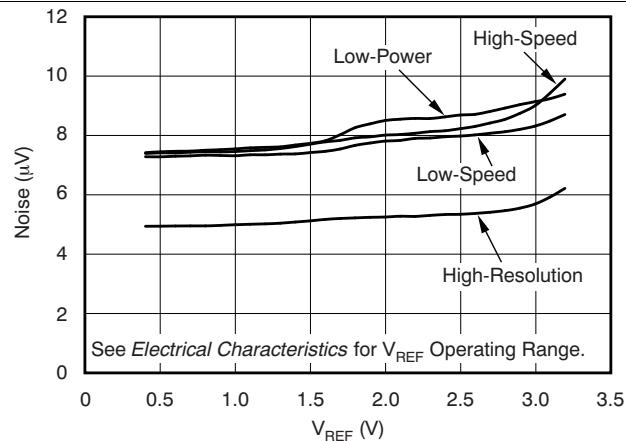


Figure 46. Noise vs Reference Voltage

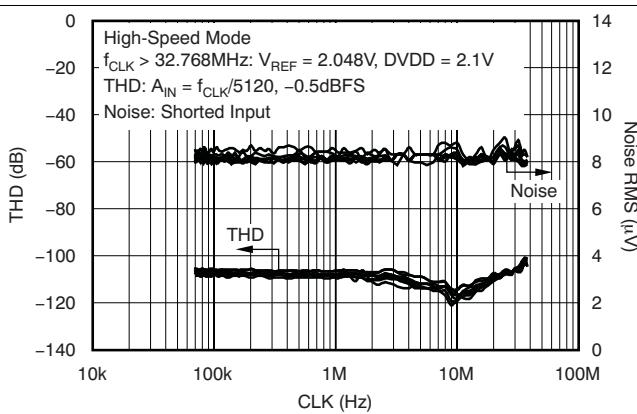


Figure 47. Total Harmonic Distortion and Noise vs CLK

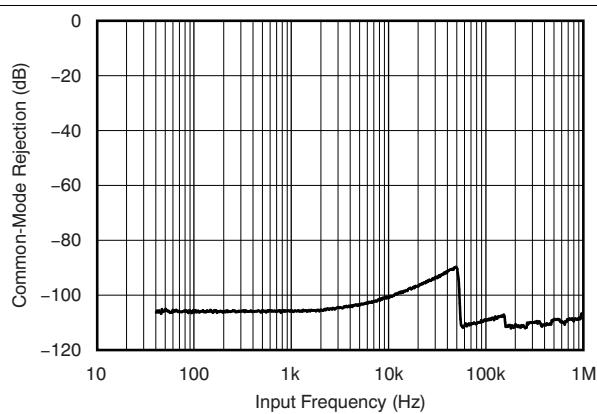


Figure 48. Common-Mode Rejection vs Input Frequency

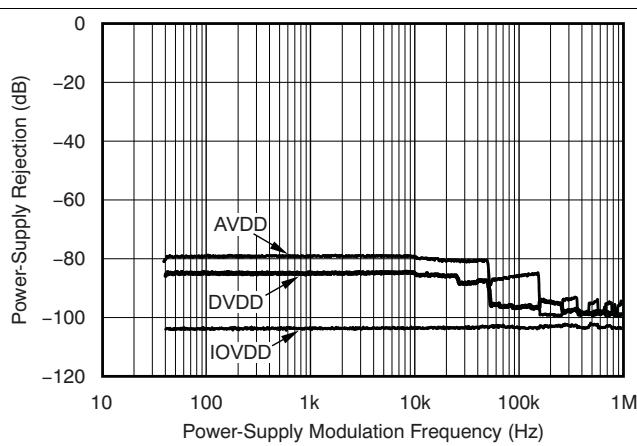


Figure 49. Power-Supply Rejection vs Power-Supply Frequency

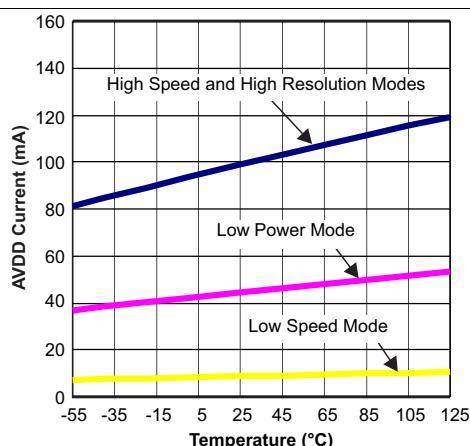


Figure 50. AVDD Current vs Temperature

Typical Characteristics (continued)

At $T_A = 25^\circ\text{C}$, High-Speed mode, AVDD = 5 V, DVDD = 1.8 V, IOVDD = 3.3 V, $f_{\text{CLK}} = 27 \text{ MHz}$, VREFP = 2.5 V, and VREFN = 0 V, unless otherwise noted.

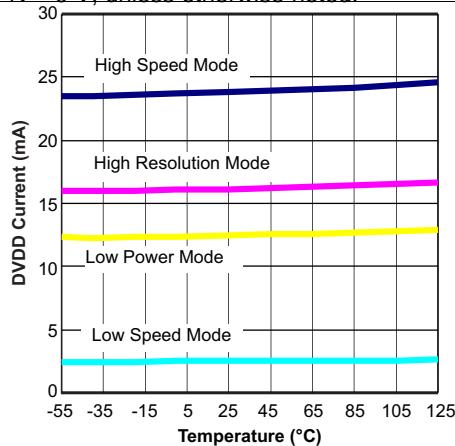


Figure 51. DVDD Current vs Temperature

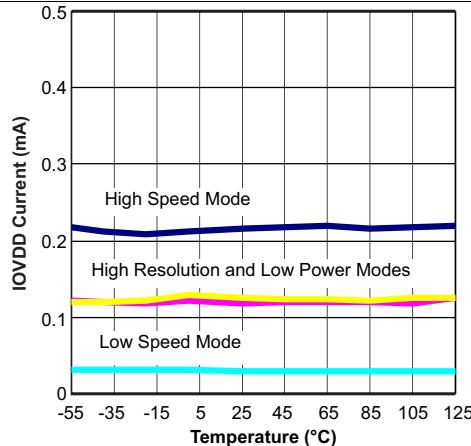


Figure 52. IOVDD Current vs Temperature

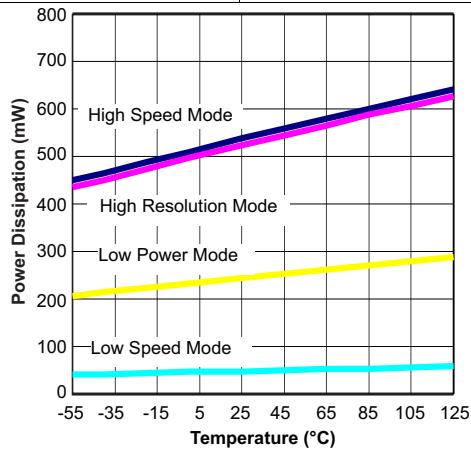


Figure 53. Power Dissipation vs Temperature

8 Detailed Description

8.1 Overview

The ADS1278-SP is a delta-sigma ADC consisting of eight independent converters that digitize eight input signals in parallel.

The converter is composed of two main functional blocks to perform the ADC conversions: the modulator and the digital filter. The modulator samples the input signal together with sampling the reference voltage to produce a 1-s density output stream. The density of the output stream is proportional to the analog input level relative to the reference voltage. The pulse stream is filtered by the internal digital filter where the output conversion result is produced.

In operation, the input signal is sampled by the modulator at a high rate (typically 64x higher than the final output data rate). The quantization noise of the modulator is moved to a higher frequency range where the internal digital filter removes it. Oversampling results in very low levels of noise within the signal passband.

Since the input signal is sampled at a very high rate, input signal aliasing does not occur until the input signal frequency is at the modulator sampling rate. This architecture greatly relaxes the requirement of external antialiasing filters because of the high modulator sampling rate.

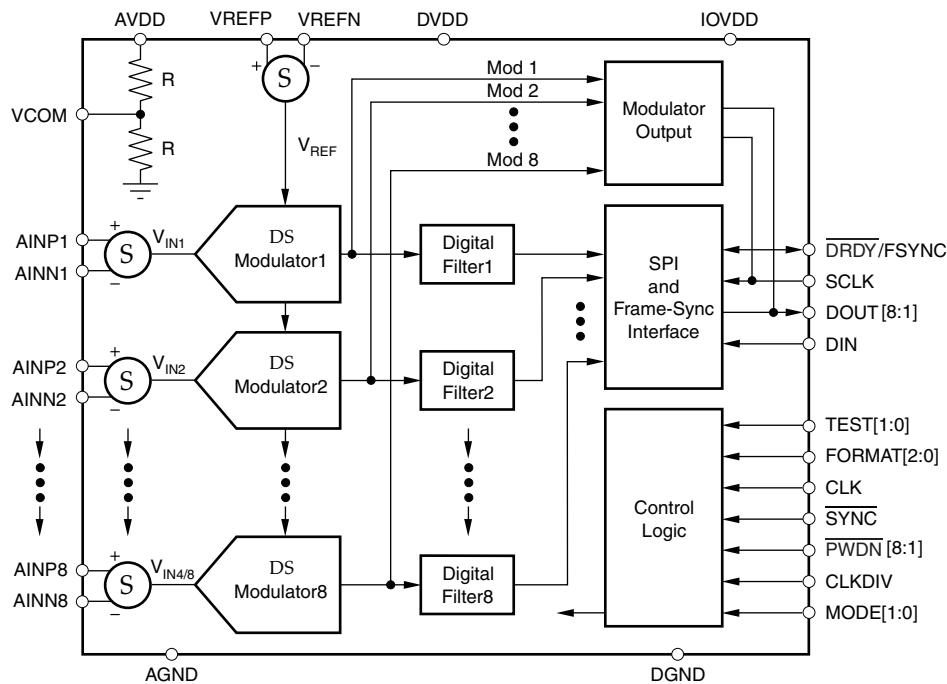
The ADS1278-SP is an octal 24-bit, delta-sigma ADC. It offers the combination of outstanding dc accuracy and superior ac performance. [Functional Block Diagram](#) section shows the block diagram. The converter is comprised of eight advanced, 6th-order, chopper-stabilized, delta-sigma modulators followed by low-ripple, linear phase FIR filters. The modulators measure the differential input signal, $V_{IN} = (AINP - AINN)$, against the differential reference, $V_{REF} = (VREFP - VREFN)$. The digital filters receive the modulator signal and provide a low-noise digital output. To allow tradeoffs among speed, resolution, and power, four operating modes are supported:

High-Speed, High-Resolution, Low-Power, and Low-Speed. [Table 15](#) summarizes the performance of each mode.

In High-Speed mode, the maximum data rate is 128 kSPS (when operating at 128 kSPS, Frame-Sync format must be used). In High-Resolution mode, the SNR = 111 dB ($V_{REF} = 3.0$ V); in Low-Power mode, the power dissipation is 31 mW/channel; and in Low-Speed mode, the power dissipation is only 7 mW/channel at 10.5 kSPS. The digital filters can be bypassed, enabling direct access to the modulator output.

The ADS1278-SP is configured by simply setting the appropriate I/O pins—there are no registers to program. Data are retrieved over a serial interface that supports both SPI and Frame-Sync formats. The ADS1278-SP has a daisy-chainable output and the ability to synchronize externally, so it can be used conveniently in systems requiring more than eight channels.

8.2 Functional Block Diagram



8.3 Feature Description

8.3.1 Sampling Aperture Matching

The ADS1278-SP converter operates from the same CLK input. The CLK input controls the timing of the modulator sampling instant. The converter is designed such that the sampling skew, or modulator sampling aperture match between channels, is controlled. Furthermore, the digital filters are synchronized to start the convolution phase at the same modulator clock cycle. This design results in excellent phase match among the ADS1278-SP channels.

Figure 37 shows the inter-device channel sample matching for the ADS1278-SP.

8.3.2 Frequency Response

The digital filter sets the overall frequency response. The filter uses a multi-stage FIR topology to provide linear phase with minimal passband ripple and high stop band attenuation. The filter coefficients are identical to the coefficients used in the [ADS1271](#). The oversampling ratio of the digital filter (that is, the ratio of the modulator sampling to the output data rate, or f_{MOD}/f_{DATA}) is a function of the selected mode, as shown in [Table 1](#).

Table 1. Oversampling Ratio vs Mode

| MODE SELECTION | OVERSAMPLING RATIO (f_{MOD}/f_{DATA}) |
|-----------------|---|
| High-Speed | 64 |
| High-Resolution | 128 |
| Low-Power | 64 |
| Low-Speed | 64 |

8.3.2.1 High-Speed, Low-Power, And Low-Speed Modes

The digital filter configuration is the same in High-Speed, Low-Power, and Low-Speed modes with the oversampling ratio set to 64. [Figure 54](#) shows the frequency response in High-Speed, Low-Power, and Low-Speed modes normalized to f_{DATA} . [Figure 55](#) shows the passband ripple. The transition from passband to stop band is shown in [Figure 56](#). The overall frequency response repeats at 64x multiples of the modulator frequency f_{MOD} , as shown in [Figure 57](#).

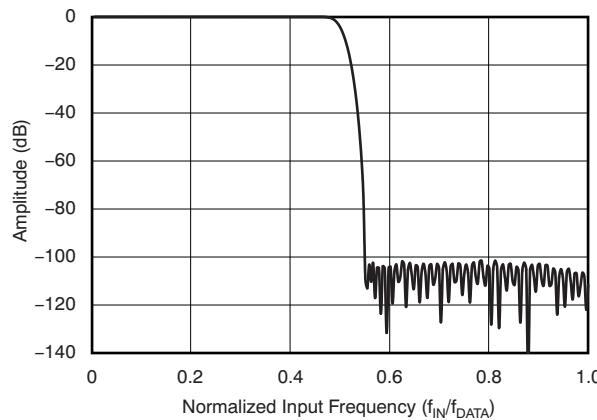


Figure 54. Frequency Response For High-Speed, Low-Power, And Low-Speed Modes

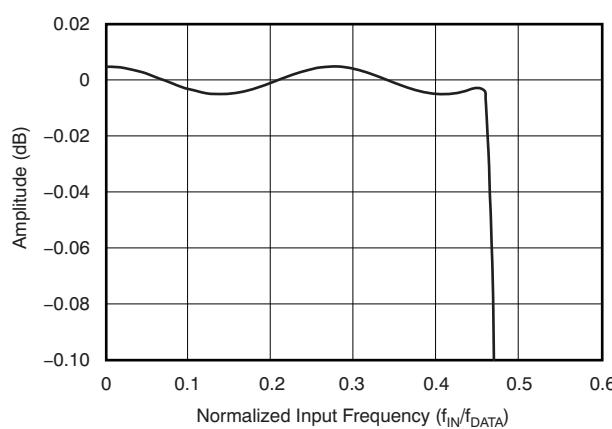


Figure 55. Passband Response For High-Speed, Low-Power, And Low-Speed Modes

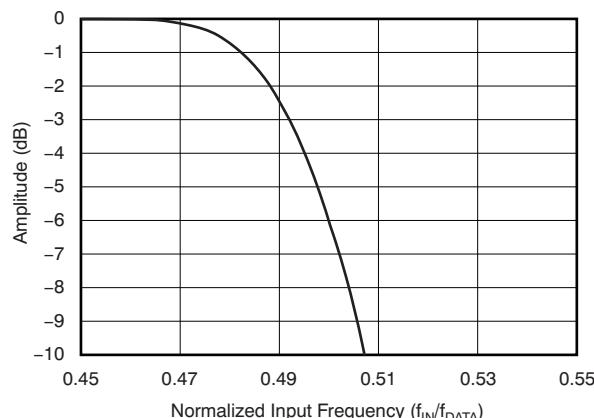


Figure 56. Transition Band Response For High-Speed, Low-Power, and Low-Speed Modes

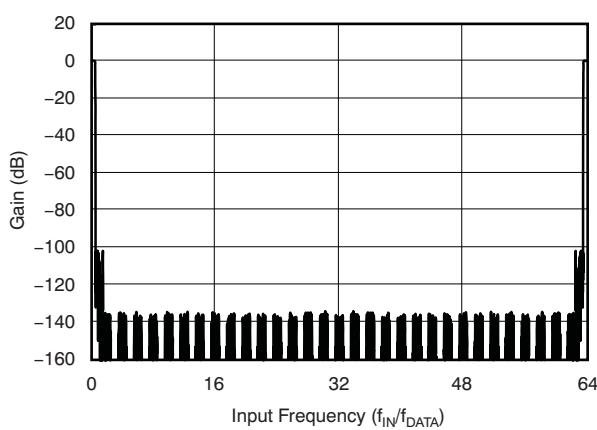


Figure 57. Frequency Response Out To f_{MOD} For High-Speed, Low-Power, And Low-Speed Modes

These image frequencies, if present in the signal and not externally filtered, will fold back (or alias) into the passband, causing errors. The stop band of the ADS1278-SP provides 100-dB attenuation of frequencies that begin just beyond the passband and continue out to f_{MOD} . Placing an anti-aliasing, low-pass filter in front of the ADS1278-SP inputs is recommended to limit possible high-amplitude, out-of-band signals and noise. Often, a simple RC filter is sufficient. [Table 2](#) lists the image rejection versus external filter order.

Table 2. Antialiasing Filter Order Image Rejection

| ANTIALIASING FILTER ORDER | IMAGE REJECTION (dB) (f_{-3dB} at f_{DATA}) | |
|---------------------------|--|-----|
| | HS, LP, LS | HR |
| 1 | 39 | 45 |
| 2 | 75 | 87 |
| 3 | 111 | 129 |

8.3.2.2 High-Resolution Mode

The oversampling ratio is 128 in High-Resolution mode. [Figure 58](#) shows the frequency response in High-Resolution mode normalized to f_{DATA} . [Figure 59](#) shows the passband ripple, and the transition from passband to stop band is shown in [Figure 60](#). The overall frequency response repeats at multiples of the modulator frequency f_{MOD} ($128 \times f_{DATA}$), as shown in [Figure 61](#). The stop band of the ADS1278-SP provides 100-dB attenuation of frequencies that begin just beyond the passband and continue out to f_{MOD} . Placing an antialiasing, low-pass filter in front of the ADS1278-SP inputs is recommended to limit possible high-amplitude out-of-band signals and noise. Often, a simple RC filter is sufficient. [Table 2](#) lists the image rejection versus external filter order.

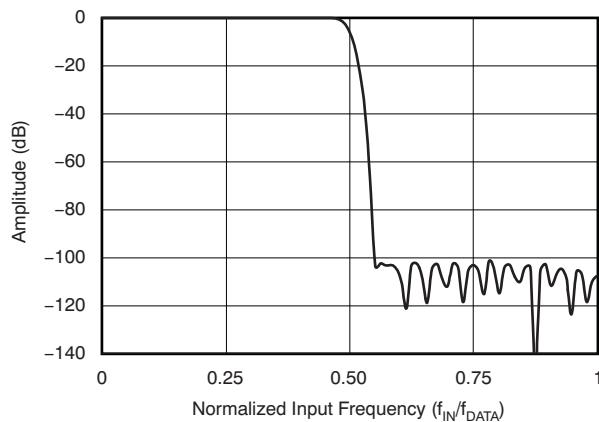


Figure 58. Frequency Response For High-Resolution Mode

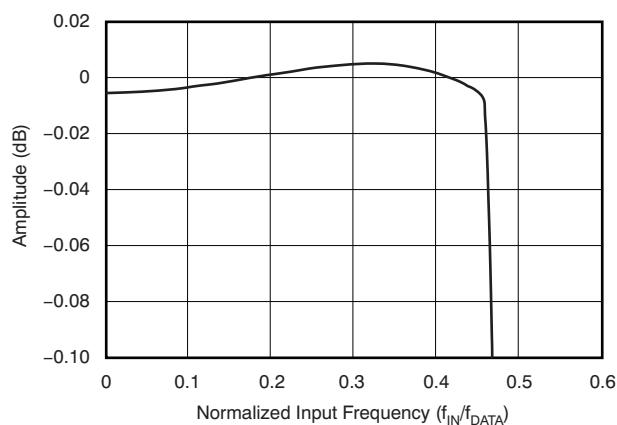


Figure 59. Passband Response For High-Resolution Mode

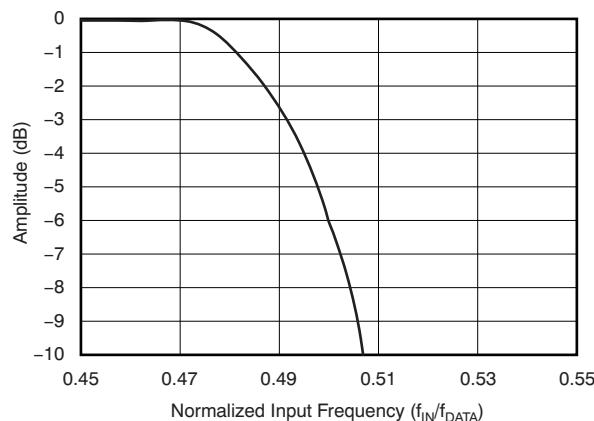


Figure 60. Transition Band Response For High-Resolution Mode

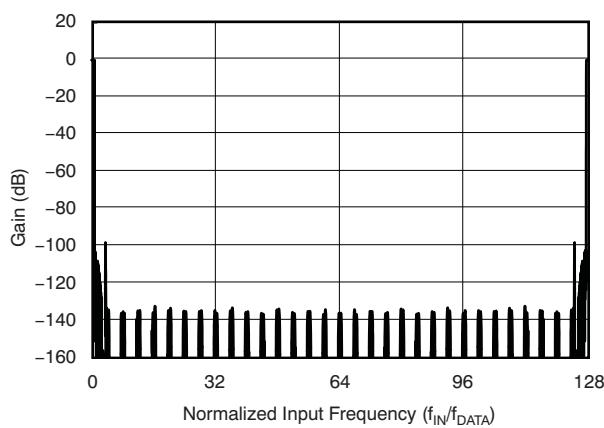


Figure 61. Frequency Response Out To F_{MOD} For High-Resolution Mode

8.3.3 Phase Response

The ADS1278-SP incorporates a multiple stage, linear phase digital filter. Linear phase filters exhibit constant delay time versus input frequency (constant group delay). This characteristic means the time delay from any instant of the input signal to the same instant of the output data is constant and is independent of input signal frequency. This behavior results in essentially zero phase errors when analyzing multi-tone signals.

8.3.4 Settling Time

As with frequency and phase response, the digital filter also determines settling time. [Figure 62](#) shows the output settling behavior after a step change on the analog inputs normalized to conversion periods. The X-axis is given in units of conversion. Note that after the step change on the input occurs, the output data change very little prior to 30 conversion periods. The output data are fully settled after 76 conversion periods for High-Speed and Low-Power modes, and 78 conversion periods for High-Resolution mode.

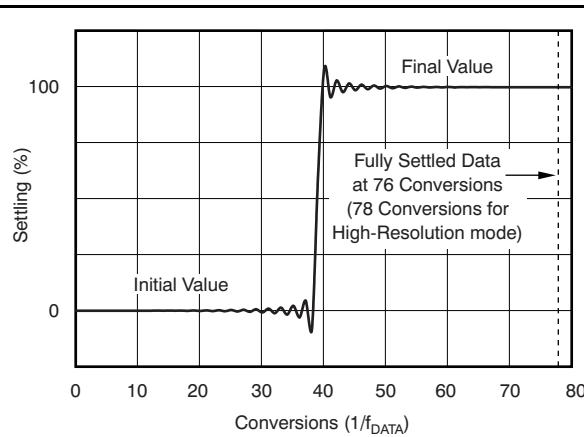


Figure 62. Step Response

8.3.5 Data Format

The ADS1278-SP outputs 24 bits of data in twos complement format.

A positive full-scale input produces an ideal output code of 7FFFFFFh, and the negative full-scale input produces an ideal output code of 800000h. The output clips at these codes for signals exceeding full-scale. [Table 3](#) summarizes the ideal output codes for different input signals.

Table 3. Ideal Output Code Versus Input Signal

| INPUT SIGNAL V _{IN} (A _{INP} – A _{INN}) | IDEAL OUTPUT CODE ⁽¹⁾ |
|--|----------------------------------|
| ≥ +V _{REF} | 7FFFFFFh |
| + V _{REF} 2 ²³ – 1 | 000001h |
| 0 | 000000h |
| - V _{REF} 2 ²³ – 1 | FFFFFFh |
| ≤ -V _{REF} (2 ²³ – 1) | 800000h |

(1) Excludes effects of noise, INL, offset, and gain errors.

8.3.6 Analog Inputs (AINP, AINN)

The ADS1278-SP measures each differential input signal $V_{IN} = (AINP - AINN)$ against the common differential reference $V_{REF} = (VREFP - VREFN)$. The most positive measurable differential input is $+V_{REF}$, which produces the most positive digital output code of 7FFFFFFh. Likewise, the most negative measurable differential input is $-V_{REF}$, which produces the most negative digital output code of 800000h.

For optimum performance, the inputs of the ADS1278-SP are intended to be driven differentially. For single-ended applications, one of the inputs (AINP or AINN) can be driven while the other input is fixed (typically to AGND or 2.5 V). Fixing the input to 2.5 V permits bipolar operation, thereby allowing full use of the entire converter range.

While the ADS1278-SP measures the differential input signal, the absolute input voltage is also important. This value is the voltage on either input (AINP or AINN) with respect to AGND. The range for this voltage is:

$$-0.1 \text{ V} < (\text{AINN or AINP}) < \text{AVDD} + 0.1 \text{ V}$$

If either input is taken below -0.4 V or above $(\text{AVDD} + 0.4)$ V, ESD protection diodes on the inputs may turn on. If these conditions are possible, external Schottky clamp diodes or series resistors may be required to limit the input current to safe values (see the *Absolute Maximum Ratings* table).

The ADS1278-SP is a very high-performance ADC. For optimum performance, it is critical that the appropriate circuitry be used to drive the ADS1278-SP inputs. See the *Application Information* section for several recommended circuits.

The ADS1278-SP uses switched-capacitor circuitry to measure the input voltage. Internal capacitors are charged by the inputs and then discharged. Figure 63 shows a conceptual diagram of these circuits. Switch S_2 represents the net effect of the modulator circuitry in discharging the sampling capacitor; the actual implementation is different. The timing for switches S_1 and S_2 is shown in Figure 64. The sampling time (t_{SAMPLE}) is the inverse of modulator sampling frequency (f_{MOD}) and is a function of the mode, the CLKDIV input, and CLK frequency, as shown in Table 4.

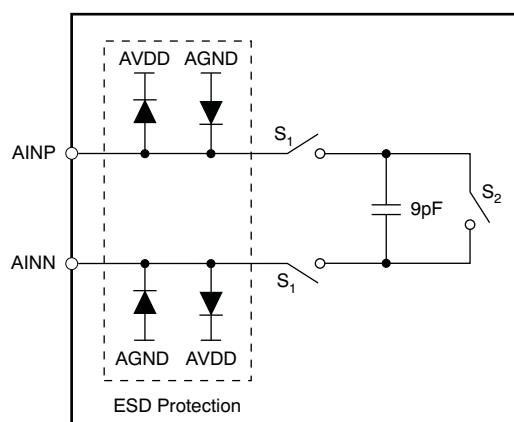


Figure 63. Equivalent Analog Input Circuitry

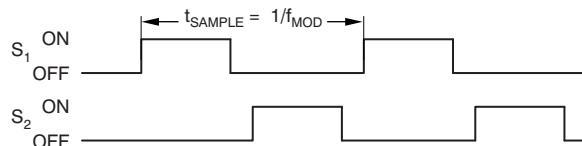


Figure 64. S_1 and S_2 Switch Timing for Figure 63

Table 4. Modulator Frequency (f_{MOD}) Mode Selection

| MODE SELECTION | CLKDIV | f_{MOD} |
|-----------------|--------|-----------------------|
| High-Speed | 1 | $f_{\text{CLK}} / 4$ |
| High-Resolution | 1 | $f_{\text{CLK}} / 4$ |
| Low-Power | 1 | $f_{\text{CLK}} / 8$ |
| | 0 | $f_{\text{CLK}} / 4$ |
| Low-Speed | 1 | $f_{\text{CLK}} / 40$ |
| | 0 | $f_{\text{CLK}} / 8$ |

The average load presented by the switched capacitor input can be modeled with an effective differential impedance, as shown in Figure 65. Note that the effective impedance is a function of f_{MOD} .

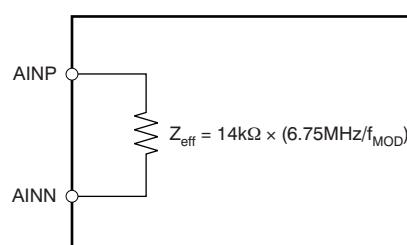


Figure 65. Effective Input Impedances

8.3.7 Voltage Reference Inputs (VREFP, VREFN)

The voltage reference for the ADS1278-SP ADC is the differential voltage between VREFP and VREFN: $V_{REF} = (VREFP - VREFN)$. The voltage reference is common to all channels. The reference inputs use a structure similar to that of the analog inputs with the equivalent circuitry on the reference inputs shown in [Figure 66](#). As with the analog inputs, the load presented by the switched capacitor can be modeled with an effective impedance, as shown in [Figure 67](#). However, the reference input impedance depends on the number of active (enabled) channels in addition to f_{MOD} . As a result of the change of reference input impedance caused by enabling and disabling channels, the regulation and setting time of the external reference should be noted, so as not to affect the readings.

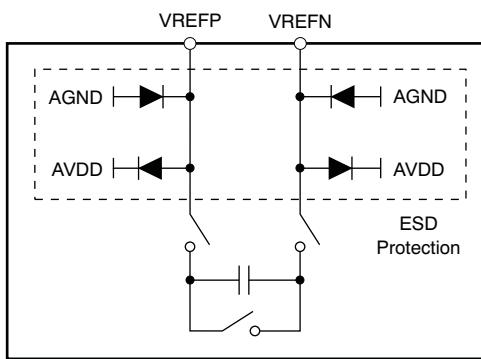
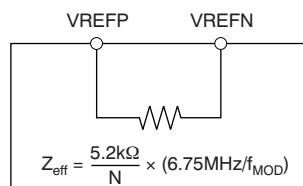


Figure 66. Equivalent Reference Input Circuitry



N = number of active channels.

Figure 67. Effective Reference Impedance

ESD diodes protect the reference inputs. To keep these diodes from turning on, make sure the voltages on the reference pins do not go below AGND by more than 0.4 V, and likewise do not exceed AVDD by 0.4 V. If these conditions are possible, external Schottky clamp diodes or series resistors may be required to limit the input current to safe values (see the [Absolute Maximum Ratings](#) table).

Note that the valid operating range of the reference inputs is limited to the following parameters:

$$-0.1 \text{ V} \leq VREFN \leq +0.1 \text{ V}$$

$$VREFN + 0.5 \text{ V} \leq VREFP \leq AVDD + 0.1 \text{ V}$$

8.3.8 Clock Input (CLK)

The ADS1278-SP requires a clock input for operation. The individual converters of the ADS1278-SP operate from the same clock input. At the maximum data rate, the clock input can be either 27 MHz or 13.5 MHz for Low-Power mode, or 27MHz or 5.4 MHz for Low-Speed mode, determined by the setting of the CLKDIV input. For High-Speed mode, the maximum CLK input frequency is 32.768 MHz. For High-Resolution mode, the maximum CLK input frequency is 27 MHz. The selection of the external clock frequency (f_{CLK}) does not affect the resolution of the ADS1278-SP. Use of a slower f_{CLK} can reduce the power consumption of an external clock buffer. The output data rate scales with clock frequency, down to a minimum clock frequency of $f_{CLK} = 100$ kHz. [Table 5](#) summarizes the ratio of the clock input frequency (f_{CLK}) to data rate (f_{DATA}), maximum data rate and corresponding maximum clock input for the four operating modes.

As with any high-speed data converter, a high-quality, low-jitter clock is essential for optimum performance. Crystal clock oscillators are the recommended clock source. Make sure to avoid excess ringing on the clock input; keeping the clock trace as short as possible, and using a 50- Ω series resistor placed close to the source end, often helps.

Table 5. Clock Input Options

| MODE SELECTION | MAX f_{CLK} (MHz) | CLKDIV | f_{CLK}/f_{DATA} | DATA RATE (SPS) |
|-----------------|---------------------|--------|--------------------|-----------------|
| High-Speed | 32.768 | 1 | 256 | 128,000 |
| High-Resolution | 27 | 1 | 512 | 52,734 |
| Low-Power | 27 | 1 | 512 | 52,734 |
| | 13.5 | 0 | 256 | |
| Low-Speed | 27 | 1 | 2,560 | 10,547 |
| | 5.4 | 0 | 512 | |

8.3.9 Mode Selection (MODE)

The ADS1278-SP supports four modes of operation: High-Speed, High-Resolution, Low-Power, and Low-Speed. The modes offer optimization of speed, resolution, and power. Mode selection is determined by the status of the digital input MODE[1:0] pins, as shown in [Table 6](#). The ADS1278-SP continually monitors the status of the MODE pin during operation.

Table 6. Mode Selection

| MODE[1:0] | MODE SELECTION | MAX $f_{DATA}^{(1)}$ |
|-----------|-----------------|----------------------|
| 00 | High-Speed | 128,000 |
| 01 | High-Resolution | 52,734 |
| 10 | Low-Power | 52,734 |
| 11 | Low-Speed | 10,547 |

(1) $f_{CLK} = 27\text{-MHz}$ max (32.768-MHz max in High-Speed mode).

When using the SPI protocol, \overline{DRDY} is held high after a mode change occurs until settled (or valid) data are ready; see [Figure 68](#) and [Table 7](#).

In Frame-Sync protocol, the DOUT pins are held low after a mode change occurs until settled data are ready; see [Figure 68](#) and [Table 7](#). Data can be read from the device to detect when DOUT changes to logic 1, indicating that the data are valid.

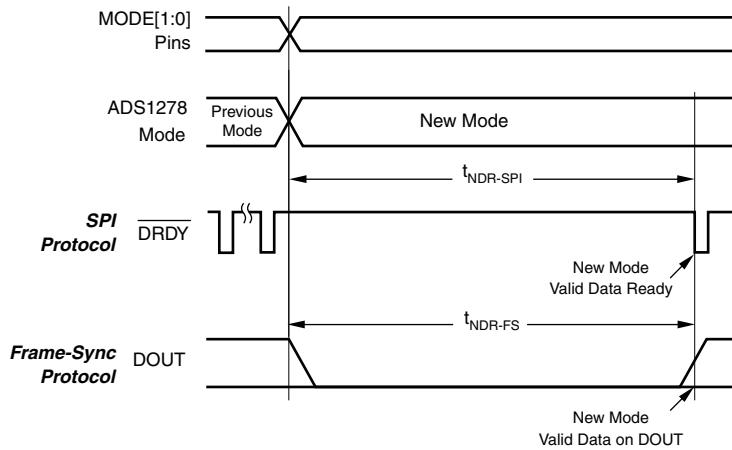


Figure 68. Mode Change Timing

Table 7. New Data After Mode Change

| SYMBOL | DESCRIPTION | MIN | TYP | MAX | UNITS |
|---------------|--|-----|-----|-----|------------------------------------|
| $t_{NDR-SPI}$ | Time for new data to be ready (SPI) | | | 129 | Conversions (1/f _{DATA}) |
| t_{NDR-FS} | Time for new data to be ready (Frame-Sync) | 127 | | 128 | Conversions (1/f _{DATA}) |

8.3.10 Synchronization (SYNC)

The ADS1278-SP can be synchronized by pulsing the SYNC pin low and then returning the pin high. When the pin goes low, the conversion process stops, and the internal counters used by the digital filter are reset. When the SYNC pin returns high, the conversion process restarts. Synchronization allows the conversion to be aligned with an external event, such as the changing of an external multiplexer on the analog inputs, or by a reference timing pulse.

Because the ADS1278-SP converters operate in parallel from the same master clock and use the same SYNC input control, they are always in synchronization with each other. The aperture match among internal channels is typically less than 500 ps. However, the synchronization of multiple devices is somewhat different. At device power-on, variations in internal reset thresholds from device to device may result in uncertainty in conversion timing.

The SYNC pin can be used to synchronize multiple devices to within the same CLK cycle. [Figure 69](#) illustrates the timing requirement of SYNC and CLK in SPI format.

See [Figure 70](#) for the Frame-Sync format timing requirement.

After synchronization, indication of valid data depends on whether SPI or Frame-Sync format was used.

In the SPI format, DRDY goes high as soon as SYNC is taken low; see [Figure 69](#). After SYNC is returned high, DRDY stays high while the digital filter is settling. Once valid data are ready for retrieval, DRDY goes low.

In the Frame-Sync format, DOUT goes low as soon as SYNC is taken low; see [Figure 70](#). After SYNC is returned high, DOUT stays low while the digital filter is settling. Once valid data are ready for retrieval, DOUT begins to output valid data. For proper synchronization, FSYNC, SCLK, and CLK must be established before taking SYNC high, and must then remain running. If the clock inputs (CLK, FSYNC or SCLK) are subsequently interrupted or reset, re-assert the SYNC pin.

For consistent performance, re-assert SYNC after device power-on when data first appear.

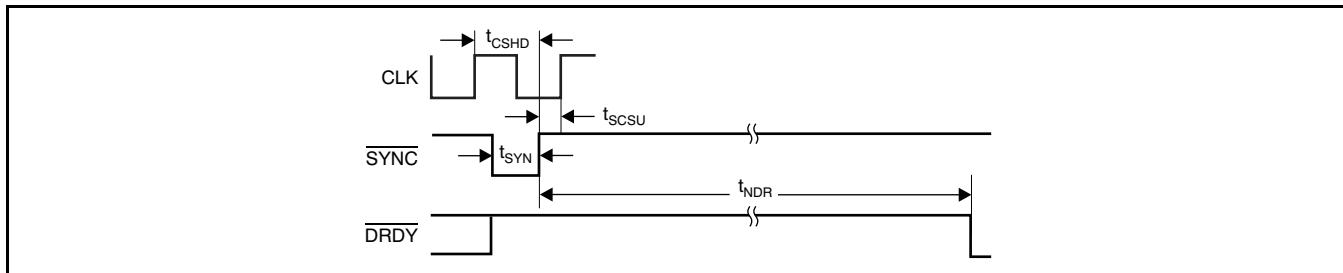


Figure 69. Synchronization Timing (SPI Protocol)

Table 8. SPI Protocol

| SYMBOL | DESCRIPTION | MIN | TYP | MAX | UNITS |
|------------------|--|-----|-----|-----|-------------------------------------|
| t_{CSHD} | CLK to $\overline{\text{SYNC}}$ hold time | 10 | | | ns |
| t_{SCSU} | $\overline{\text{SYNC}}$ to CLK setup time | 5 | | | ns |
| t_{SYN} | Synchronize pulse width | 1 | | | CLK periods |
| t_{NDR} | Time for new data to be ready | | 129 | | Conversions (1/ f_{DATA}) |

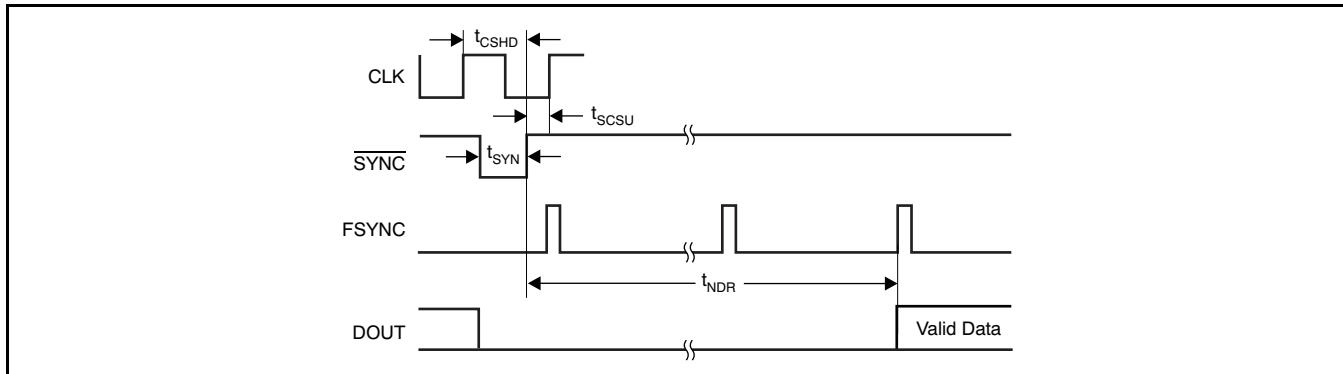


Figure 70. Synchronization Timing (Frame-Sync Protocol)

Table 9. Frame-Sync Protocol

| SYMBOL | DESCRIPTION | MIN | TYP | MAX | UNITS |
|------------------|--|-----|-----|-----|-------------------------------------|
| t_{CSHD} | CLK to $\overline{\text{SYNC}}$ hold time | 10 | | | ns |
| t_{SCSU} | $\overline{\text{SYNC}}$ to CLK setup time | 5 | | | ns |
| t_{SYN} | Synchronize pulse width | 1 | | | CLK periods |
| t_{NDR} | Time for new data to be ready | 127 | 128 | | Conversions (1/ f_{DATA}) |

8.3.11 Power-Down (PWDN)

The channels of the ADS1278-SP can be independently powered down by use of the PWDN inputs. To enter the power-down mode, hold the respective PWDN pin low for at least two CLK cycles. To exit power-down, return the corresponding PWDN pin high. Note that when all channels are powered down, the ADS1278-SP enters a microwatt (μ W) power state where all internal biasing is disabled. In this state, the TEST[1:0] input pins must be driven; all other input pins can float. The ADS1278-SP outputs remain driven.

As shown in [Figure 71](#) and [Table 10](#), a maximum of 130 conversion cycles must elapse for SPI interface, and 129 conversion cycles must elapse for Frame-Sync, before reading data after exiting power-down. Data from channels already running are not affected. The user software can perform the required delay time in any of the following ways:

1. Count the number of data conversions after taking the PWDN pin high.
2. Delay $129/f_{DATA}$ or $130/f_{DATA}$ after taking the PWDN pins high, then read data.

3. Detect for non-zero data in the powered-up channel.

After powering up one or more channels, the channels are synchronized to each other. It is not necessary to use the SYNC pin to synchronize them.

When a channel is powered down in TDM data format, the data for that channel are either forced to zero (fixed-position TDM data mode) or replaced by shifting the data from the next channel into the vacated data position (dynamic-position TDM data mode).

In Discrete data format, the data are always forced to zero. When powering-up a channel in dynamic-position TDM data format mode, the channel data remain packed until the data are ready, at which time the data frame is expanded to include the just-powered channel data. See the *Data Format* section for details.

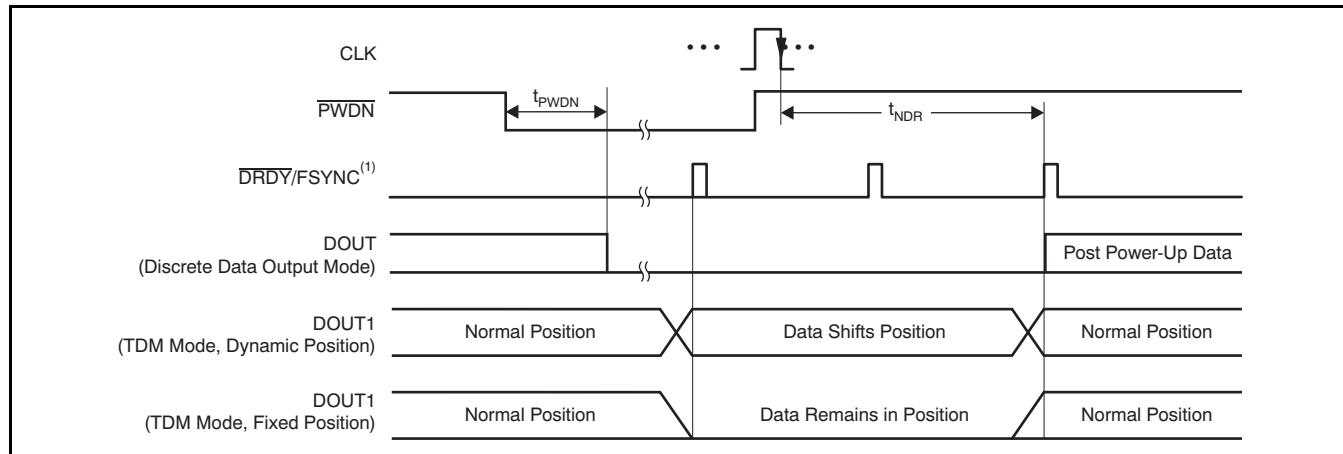


Figure 71. Power-Down Timing

Table 10. Power-Down Timing

| SYMBOL | DESCRIPTION | MIN | TYP | MAX | UNITS |
|------------|---|-----|-----|-----|------------------------------|
| t_{PWDN} | PWDN pulse width to enter Power-Down mode | 2 | | | CLK periods |
| t_{NDR} | Time for new data ready (SPI) | 129 | | 130 | Conversions (1/ f_{DATA}) |
| t_{NDR} | Time for new data ready (Frame-Sync) | 128 | | 129 | Conversions (1/ f_{DATA}) |

8.3.12 Format[2:0]

Data can be read from the ADS1278-SP with two interface protocols (SPI or Frame-Sync) and several options of data formats (TDM/Discrete and Fixed/Dynamic data positions). The FORMAT[2:0] inputs are used to select among the options. [Table 11](#) lists the available options. See the [DOUT Modes](#) section for details of the DOUT Mode and Data Position.

Table 11. Data Output Format

| FORMAT[2:0] | INTERFACE PROTOCOL | DOUT MODE | DATA POSITION |
|-------------|--------------------|-----------|---------------|
| 000 | SPI | TDM | Dynamic |
| 001 | SPI | TDM | Fixed |
| 010 | SPI | Discrete | — |
| 011 | Frame-Sync | TDM | Dynamic |
| 100 | Frame-Sync | TDM | Fixed |
| 101 | Frame-Sync | Discrete | — |
| 110 | Modulator Mode | — | — |

8.3.13 Serial Interface Protocols

Data are retrieved from the ADS1278-SP using the serial interface. Two protocols are available: SPI and Frame-Sync. The same pins are used for both interfaces: SCLK, $\overline{\text{DRDY}}/\text{FSYNC}$, DOUT[8:1], and DIN. The FORMAT[2:0] pins select the desired interface protocol.

8.3.14 SPI Serial Interface

The SPI-compatible format is a read-only interface. Data ready for retrieval are indicated by the falling $\overline{\text{DRDY}}$ output and are shifted out on the falling edge of SCLK, MSB first. The interface can be daisy-chained using the DIN input when using multiple devices. See the [Daisy-Chaining](#) section for more information.

NOTE: The SPI format is limited to a CLK input frequency of 27 MHz, maximum. For CLK input operation above 27 MHz (High-Speed mode only), use Frame-Sync format.

8.3.14.1 SCLK

The serial clock (SCLK) features a Schmitt-triggered input and shifts out data on DOUT on the falling edge. It also shifts in data on the falling edge on DIN when this pin is being used for daisy-chaining. The device shifts data out on the falling edge and the user normally shifts this data in on the rising edge.

Even though the SCLK input has hysteresis, it is recommended to keep SCLK as clean as possible to prevent glitches from accidentally shifting the data.

SCLK may be run as fast as the CLK frequency. SCLK may be either in free-running or stop-clock operation between conversions. Note that one f_{CLK} is required after the falling edge of $\overline{\text{DRDY}}$ until the first rising edge of SCLK. For best performance, limit $f_{\text{SCLK}} / f_{\text{CLK}}$ to ratios of 1, 1/2, 1/4, 1/8, etc. When the device is configured for modulator output, SCLK becomes the modulator clock output (see the [Modulator Output](#) section).

8.3.14.2 $\overline{\text{DRDY}}/\text{FSYNC}$ (SPI Format)

In the SPI format, this pin functions as the $\overline{\text{DRDY}}$ output. It goes low when data are ready for retrieval and then returns high on the falling edge of the first subsequent SCLK. If data are not retrieved (that is, SCLK is held low), $\overline{\text{DRDY}}$ pulses high just before the next conversion data are ready, as shown in [Figure 72](#). The new data are loaded within one CLK cycle before $\overline{\text{DRDY}}$ goes low. All data must be shifted out before this time to avoid being overwritten.

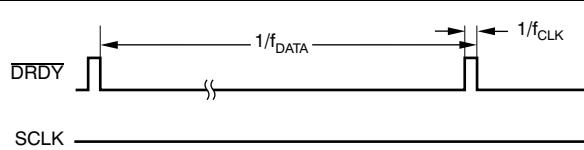


Figure 72. $\overline{\text{DRDY}}$ Timing With No Readback

8.3.14.3 DOUT

The conversion data are output on DOUT[8:1]. The MSB data are valid on DOUT[8:1] after $\overline{\text{DRDY}}$ goes low. Subsequent bits are shifted out with each falling edge of SCLK. If daisy-chaining, the data shifted in using DIN appear on DOUT after all channel data have been shifted out. When the device is configured for modulator output, DOUT[8:1] becomes the modulator data output for each channel (see the [Modulator Output](#) section).

8.3.14.4 DIN

This input is used when multiple ADS1278-SPs are to be daisy-chained together. The DOUT1 pin of the first device connects to the DIN pin of the next, etc. It can be used with either the SPI or Frame-Sync formats. Data are shifted in on the falling edge of SCLK. When using only one ADS1278-SP, tie DIN low. See the [Daisy-Chaining](#) section for more information.

8.3.15 Frame-Sync Serial Interface

Frame-Sync format is similar to the interface often used on audio ADCs. It operates in slave fashion—the user must supply framing signal FSYNC (similar to the *left/right clock* on stereo audio ADCs) and the serial clock SCLK (similar to the *bit clock* on audio ADCs). The data are output MSB first or *left-justified* on the rising edge of FSYNC. When using Frame-Sync format, the FSYNC and SCLK inputs must be continuously running with the relationships shown in the [Timing Requirements: Frame-Sync Format](#) table.

8.3.15.1 SCLK

The serial clock (SCLK) features a Schmitt-triggered input and shifts out data on DOUT on the falling edge. It also shifts in data on the falling edge on DIN when this pin is being used for daisy-chaining. Even though SCLK has hysteresis, it is recommended to keep SCLK as clean as possible to prevent glitches from accidentally shifting the data. When using Frame-Sync format, SCLK must run continuously. If it is shut down, the data readback will be corrupted. The number of SCLKs within a frame period (FSYNC clock) can be any power-of-2 ratio of CLK cycles (1, 1/2, 1/4, etc), as long as the number of cycles is sufficient to shift the data output from all channels within one frame. When the device is configured for modulator output, SCLK becomes the modulator clock output (see the [Modulator Output](#) section).

8.3.15.2 DRDY/FSYNC (Frame-Sync Format)

In Frame-Sync format, this pin is used as the FSYNC input. The frame-sync input (FSYNC) sets the frame period, which must be the same as the data rate. The required number of f_{CLK} cycles to each FSYNC period depends on the mode selection and the CLKDIV input. [Table 5](#) indicates the number of CLK cycles to each frame (f_{CLK}/f_{DATA}). If the FSYNC period is not the proper value, data readback will be corrupted.

8.3.15.3 DOUT

The conversion data are shifted out on DOUT[8:1]. The MSB data become valid on DOUT[8:1] after FSYNC goes high. The subsequent bits are shifted out with each falling edge of SCLK. If daisy-chaining, the data shifted in using DIN appear on DOUT[8:1] after all channel data have been shifted out. When the device is configured for modulator output, DOUT becomes the modulator data output (see the [Modulator Output](#) section).

8.3.15.4 DIN

This input is used when multiple ADS1278-SPs are to be daisy-chained together. It can be used with either SPI or Frame-Sync formats. Data are shifted in on the falling edge of SCLK. When using only one ADS1278-SP, tie DIN low. See the [Daisy-Chaining](#) section for more information.

8.3.16 DOUT Modes

For both SPI and Frame-Sync interface protocols, the data are shifted out either through individual channel DOUT pins, in a parallel data format (Discrete mode), or the data for all channels are shifted out, in a serial format, through a common pin, DOUT1 (TDM mode).

8.3.16.1 TDM Mode

In TDM (time-division multiplexed) data output mode, the data for all channels are shifted out, in sequence, on a single pin (DOUT1). As shown in [Figure 73](#), the data from channel 1 are shifted out first, followed by channel 2 data, etc. After the data from the last channel are shifted out, the data from the DIN input follow. The DIN is used to daisy-chain the data output from an additional ADS1278-SP or other compatible device. Note that when all channels of the ADS1278-SP are disabled, the interface is disabled, rendering the DIN input disabled as well. When one or more channels of the device are powered down, the data format of the TDM mode can be fixed or dynamic.

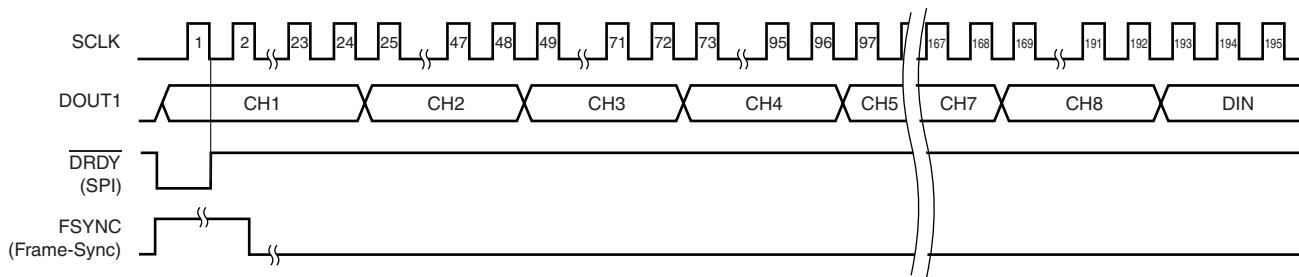


Figure 73. TDM Mode (All Channels Enabled)

8.3.16.2 TDM Mode, Fixed-Position Data

In this TDM data output mode, the data position of the channels remain fixed, regardless of whether the channels are powered down. If a channel is powered down, the data are forced to zero but occupy the same position within the data stream. [Figure 74](#) shows the data stream with channel 1 and channel 3 powered down.

8.3.16.3 TDM Mode, Dynamic Position Data

In this TDM data output mode, when a channel is powered down, the data from higher channels shift one position in the data stream to fill the vacated data slot. [Figure 75](#) shows the data stream with channel 1 and channel 3 powered down.

8.3.16.4 Discrete Data Output Mode

In Discrete data output mode, the channel data are shifted out in parallel using individual channel data output pins DOUT[8:1]. After the 24th SCLK, the channel data are forced to zero. The data are also forced to zero for powered down channels. [Figure 76](#) shows the discrete data output format.

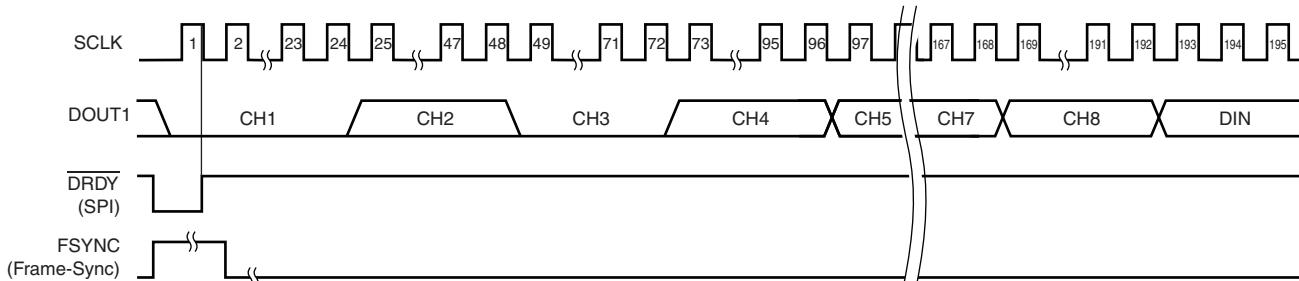


Figure 74. TDM Mode, Fixed-Position Data (Channels 1 And 3 Shown Powered Down)

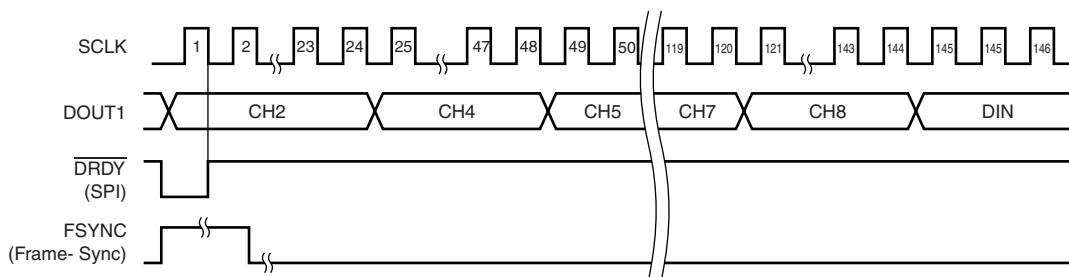


Figure 75. TDM Mode, Dynamic Position Data (Channels 1 And 3 Shown Powered Down)

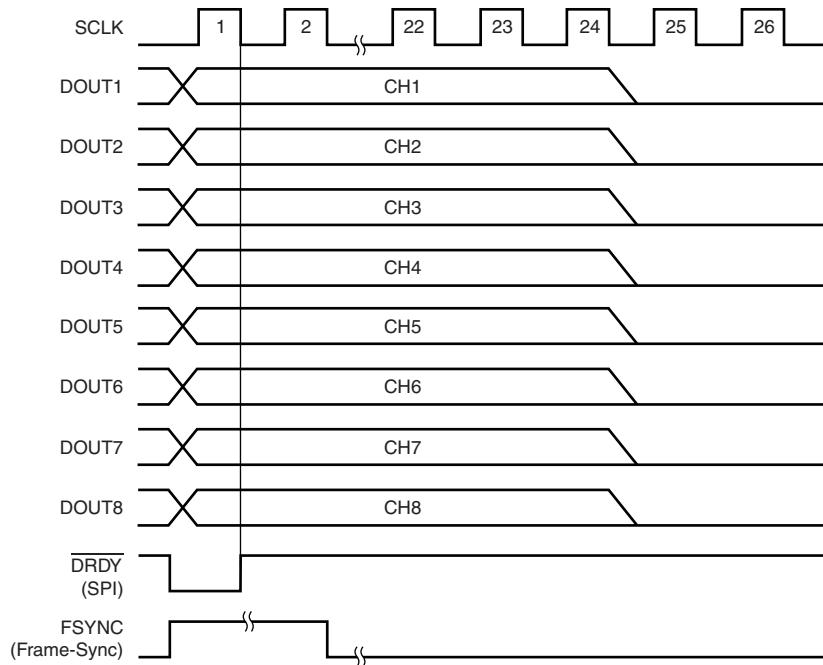


Figure 76. Discrete Data Output Mode

8.3.17 Daisy-Chaining

Multiple ADS1278-SPs can be daisy-chained together to output data on a single pin. The DOUT1 data output pin of one device is connected to the DIN of the next device. As shown in [Figure 77](#), the DOUT1 pin of device 1 provides the output data to a controller, and the DIN of device 2 is grounded. [Figure 78](#) shows the data format when reading back data.

The maximum number of channels that may be daisy-chained in this way is limited by the frequency of f_{SCLK} , the mode selection, and the CLKDIV input. The frequency of f_{SCLK} must be high enough to completely shift the data out from all channels within one f_{DATA} period. [Table 12](#) lists the maximum number of daisy-chained channels when $f_{SCLK} = f_{CLK}$.

To increase the number of data channels possible in a chain, a segmented DOUT scheme may be used, producing two data streams. [Figure 79](#) illustrates four ADS1278-SPs, with pairs of ADS1278-SPs daisy-chained together. The channel data of each daisy-chained pair are shifted out in parallel and received by the processor through independent data channels.

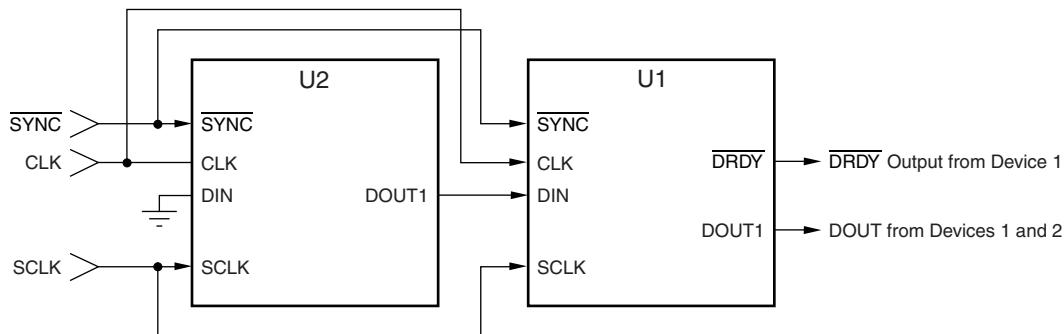
Table 12. Maximum Channels In A Daisy-Chain ($F_{SCLK} = F_{CLK}$)

| MODE SELECTION | CLKDIV | MAXIMUM NUMBER OF CHANNELS |
|-----------------|--------|----------------------------|
| High-Speed | 1 | 10 |
| High-Resolution | 1 | 21 |
| Low-Power | 1 | 21 |
| | 0 | 10 |
| Low-Speed | 1 | 106 |
| | 0 | 21 |

Whether the interface protocol is SPI or Frame-Sync, it is recommended to synchronize all devices by tying the SYNC inputs together. When synchronized in SPI protocol, it is only necessary to monitor the DRDY output of one ADS1278-SP.

In Frame-Sync interface protocol, the data from all devices are ready after the rising edge of FSYNC.

Since DOUT1 and DIN are both shifted on the falling edge of SCLK, the propagation delay on DOUT1 creates a setup time on DIN. Minimize the skew in SCLK to avoid timing violations.



Note: The number of chained devices is limited by the SCLK rate and device mode.

Figure 77. Daisy-Chain Diagram of Two Devices, SPI Protocol (Format[2:0] = 000 or 001)

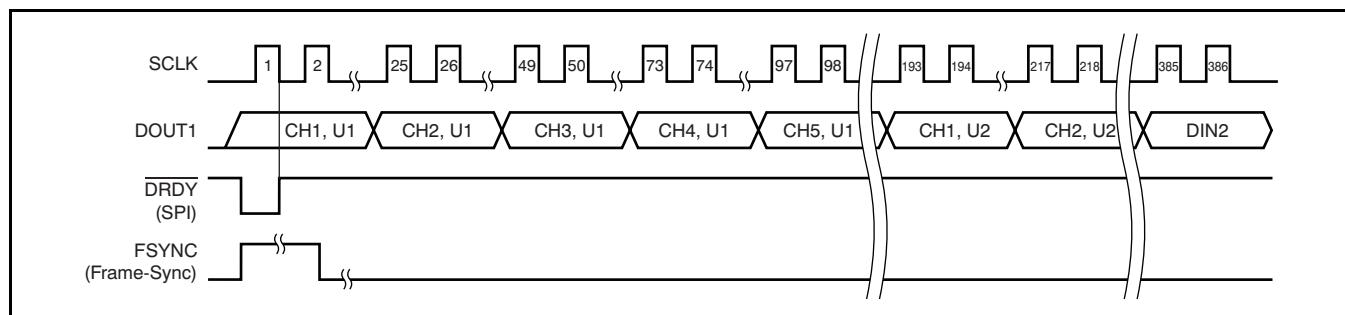
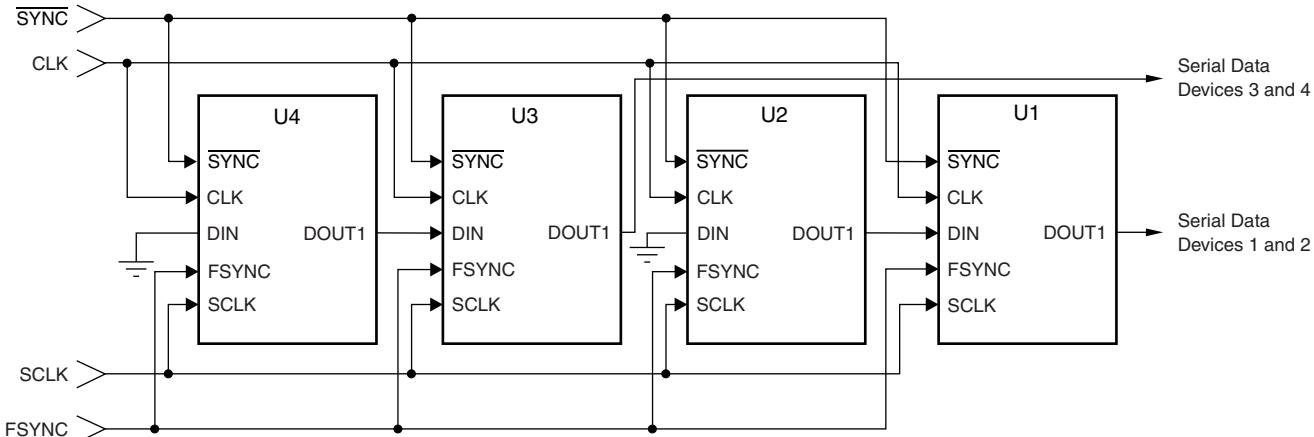


Figure 78. Daisy-Chain Data Format of Figure 77



Note: The number of chained devices is limited by the SCLK rate and device mode.

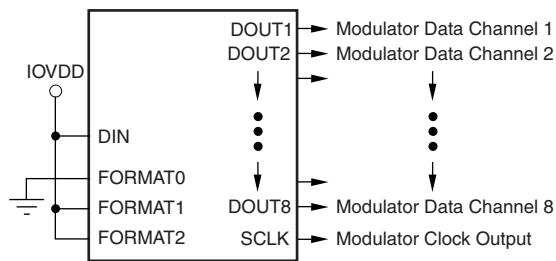
Figure 79. Segmented DOUT Daisy-Chain, Frame-Sync Protocol (Format[2:0] = 011 or 100)

8.3.18 Modulator Output

The ADS1278-SP incorporates a 6th-order, single-bit, chopper-stabilized modulator followed by a multi-stage digital filter that yields the conversion results. The data stream output of the modulator is available directly, bypassing the internal digital filter. The digital filter is disabled, reducing the DVDD current, as shown in [Table 13](#). In this mode, an external digital filter implemented in an ASIC, FPGA, or similar device is required. To invoke the modulator output, tie [FORMAT\[2:0\]](#), as shown in [Figure 80](#). DOUT[8:1] then becomes the modulator data stream outputs for each channel and SCLK becomes the modulator clock output. The DRDY/FSYNC pin becomes an unused output and can be ignored. The normal operation of the Frame-Sync and SPI interfaces is disabled, and the functionality of SCLK changes from an input to an output, as shown in [Figure 80](#).

Table 13. Modulator Output Clock Frequencies

| MODE [1:0] | CLKDIV | MODULATOR CLOCK OUTPUT (SCLK) | DVDD (mA) |
|---------------|--------|-------------------------------|-----------|
| 00 | 1 | $f_{CLK} / 4$ | 8 |
| 01 | 1 | $f_{CLK} / 4$ | 7 |
| 10 | 1 | $f_{CLK} / 8$ | 4 |
| | 0 | $f_{CLK} / 4$ | 4 |
| 11 | 1 | $f_{CLK} / 40$ | 1 |
| | 0 | $f_{CLK} / 8$ | 1 |


Figure 80. Modulator Output

In modulator output mode, the frequency of the modulator clock output (SCLK) depends on the mode selection of the ADS1278-SP. **Table 13** lists the modulator clock output frequency and DVDD current versus device mode.

Figure 81 shows the timing relationship of the modulator clock and data outputs.

The data output is a modulated 1s density data stream. When $V_{IN} = +V_{REF}$, the 1s density is approximately 80% and when $V_{IN} = -V_{REF}$, the 1s density is approximately 20%.

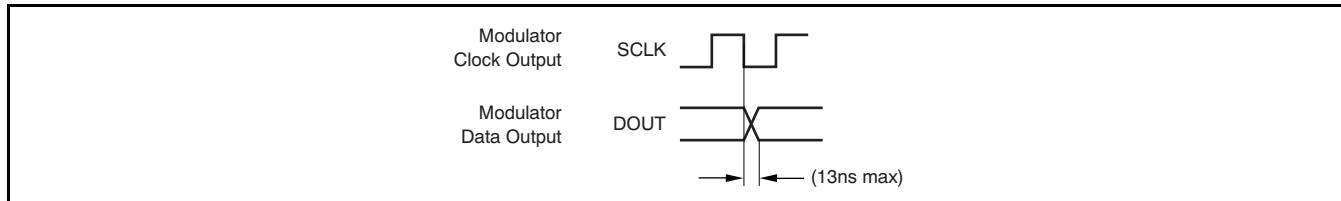


Figure 81. Modulator Output Timing

8.3.19 Pin Test Using Test[1:0] Inputs

The test mode feature of the ADS1278-SP allows continuity testing of the digital I/O pins. In this mode, the normal functions of the digital pins are disabled and routed to each other as pairs through internal logic, as shown in **Table 14**. The pins in the left column drive the output pins in the right column. **Note:** some of the digital input pins become outputs; these outputs must be accommodated in the design. The analog input, power supply, and ground pins all remain connected as normal. The test mode is engaged by setting the pins TEST [1:0] = 11. For normal converter operation, set TEST[1:0] = 00. Do not use '01' or '10'.

Table 14. Test Mode Pin Map (Test[1:0] = 11)

| TEST MODE PIN MAP | |
|--------------------|-------------|
| INPUT PINS | OUTPUT PINS |
| $\overline{PWDN1}$ | DOUT1 |
| $\overline{PWDN2}$ | DOUT2 |
| $\overline{PWDN3}$ | DOUT3 |
| $\overline{PWDN4}$ | DOUT4 |
| $\overline{PWDN5}$ | DOUT5 |
| $\overline{PWDN6}$ | DOUT6 |
| $\overline{PWDN7}$ | DOUT7 |
| $\overline{PWDN8}$ | DOUT8 |
| MODE0 | DIN |
| MODE1 | SYNC |
| FORMAT0 | CLKDIV |
| FORMAT1 | FSYNC/DRDY |
| FORMAT2 | SCLK |

8.3.20 VCOM Output

The VCOM pin provides a voltage output equal to $AVDD / 2$. The intended use of this output is to set the output common-mode level of the analog input drivers. The drive capability of the output is limited; therefore, the output should only be used to drive high-impedance nodes ($> 1 \text{ M}\Omega$). In some cases, an external buffer may be necessary. A $0.1\text{-}\mu\text{F}$ bypass capacitor is recommended to reduce noise pickup.

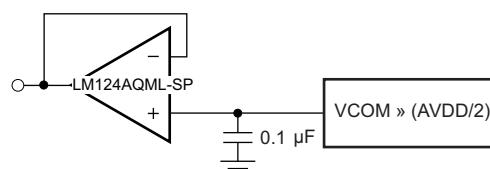


Figure 82. VCOM Output

8.4 Device Functional Modes

Table 15. Operating Mode Performance Summary

| MODE | MAX DATA RATE (SPS) | PASSBAND (kHz) | SNR (dB) | NOISE (μ V _{RMS}) | POWER/CHANNEL (mW) |
|-----------------|---------------------|----------------|----------|----------------------------------|--------------------|
| High-Speed | 128,000 | 57,984 | 106 | 8.5 | 70 |
| High-Resolution | 52,734 | 23,889 | 110 | 5.5 | 64 |
| Low-Power | 52,734 | 23,889 | 106 | 8.5 | 31 |
| Low-Speed | 10,547 | 4,798 | 107 | 8.0 | 7 |

9 Application and Implementation

NOTE

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

9.1 Application Information

The ADS1278-SP is a radiation-hardened high resolution delta-sigma ADC that is ideal for precision sensing and high accuracy instrumentation applications. With eight simultaneous sampling 24-bit ADCs integrated, the device reduces the board area needed to digitize eight analog signals.

9.2 Typical Application

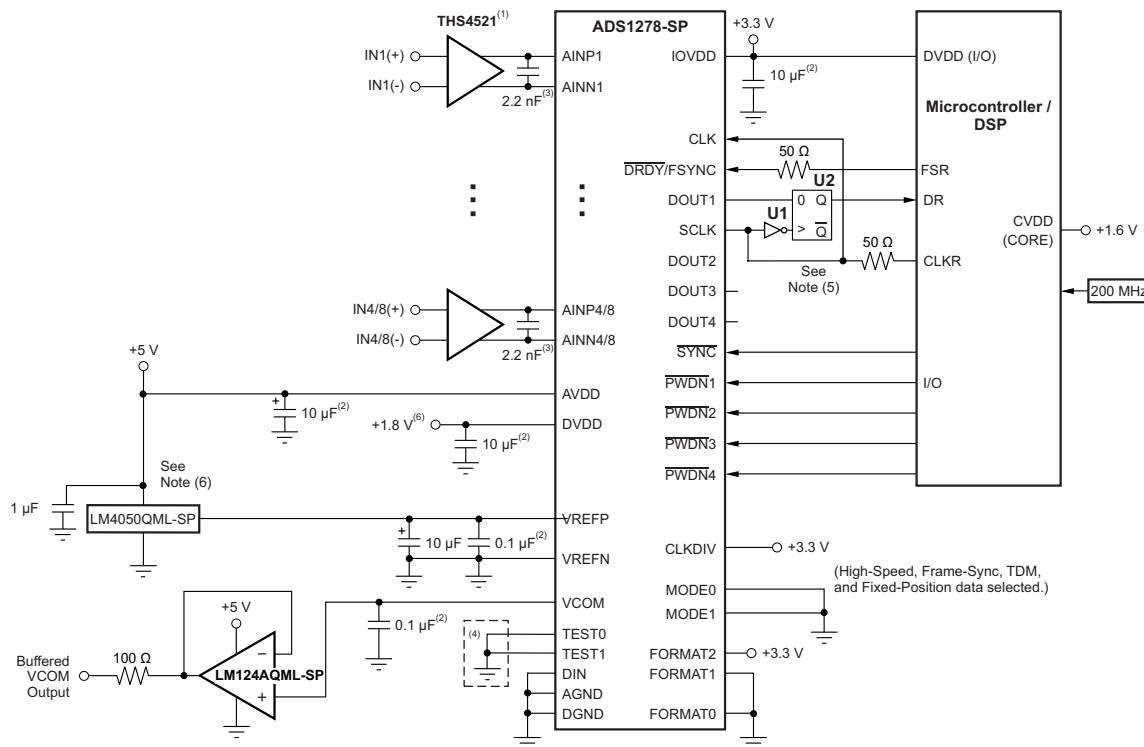


Figure 83. Typical Application Schematic

9.2.1 Design Requirements

Depending on the accuracy and speed requirements of the sensing application to be digitized by the ADC1278-SP, users must first determine the optimal device configuration. Table 16 shows the possible configurations for device for the maximum fCLKIN for each configuration. The yellow highlighted columns indicate user defined inputs (through I/O pins) to the device, while the italic row indicates the default configuration of the ADS1278EVM-CVAL EVM that is available as a reference design. As shown, a maximum data rate of 52734 SPS is possible while using the High Resolution mode, which yields a typical SNR of 111 dB or an ENOB of 18 bits.

Typical Application (continued)

Table 16. ADS1278-SP Configuration Modes

| Mode | CLKDIV | fCLK/fMOD | fCLKIN_max (MHz) | Oversampling (fMOD/fDATA) | fMOD (MHz) | fDATA_max (SPS) | fCLKIN/fMOD |
|-------------------|--------|-----------|------------------|---------------------------|------------|-----------------|-------------|
| High-Speed | 1 | 4 | 32.768 | 64 | 8.192 | 128000 | 4 |
| High-Speed | 1 | 4 | 32.768 | 64 | 8.192 | 128000 | 4 |
| <i>High-Speed</i> | 1 | 4 | 27 | 64 | 6.75 | 105469 | 4 |
| High Resolution | 1 | 4 | 27 | 128 | 6.75 | 52734 | 4 |
| Low-Power | 1 | 8 | 27 | 64 | 3.375 | 52734 | 8 |
| Low-Power | 0 | 4 | 13.5 | 64 | 3.375 | 52734 | 4 |
| Low-Speed | 1 | 40 | 27 | 64 | 0.675 | 10547 | 40 |
| Low-Speed | 0 | 8 | 5.4 | 64 | 0.675 | 10547 | 8 |

9.2.2 Detailed Design Procedure

To obtain the specified performance from the ADS1278-SP, the following layout and component guidelines should be considered.

- Power Supplies:** The device requires three power supplies for operation: DVDD, IOVDD, and AVDD. The allowed range for DVDD is 1.65 V to 1.95 V; the range of IOVDD is 1.65 V to 3.6 V; AVDD is restricted to 4.75 V to 5.25 V. For all supplies, use a 10- μ F tantalum capacitor, bypassed with a 0.1- μ F ceramic capacitor, placed close to the device pins. Alternatively, a single 10- μ F ceramic capacitor can be used. The supplies should be relatively free of noise and should not be shared with devices that produce voltage spikes (such as relays, LED display drivers, etc.). If a switching power-supply source is used, the voltage ripple should be low (less than 2 mV) and the switching frequency outside the passband of the converter.
- Ground Plane:** A single ground plane connecting both AGND and DGND pins can be used. If separate digital and analog grounds are used, connect the grounds together at the converter.
- Digital Inputs:** It is recommended to source-terminate the digital inputs to the device with 50- Ω series resistors. The resistors should be placed close to the driving end of digital source (oscillator, logic gates, DSP, etc.) This placement helps to reduce ringing on the digital lines (ringing may lead to degraded ADC performance).
- Analog/Digital Circuits:** Place analog circuitry (input buffer, reference) and associated tracks together, keeping them away from digital circuitry (DSP, microcontroller, logic). Avoid crossing digital tracks across analog tracks to reduce noise coupling and crosstalk.
- Reference Inputs:** It is recommended to use a minimum 10- μ F tantalum with a 0.1- μ F ceramic capacitor directly across the reference inputs, VREFP and VREFN. The reference input should be driven by a low-impedance source. For best performance, the reference should have less than 3- μ V_{RMS} in-band noise. For references with noise higher than this level, external reference filtering may be necessary.
- Analog Inputs:** The analog input pins must be driven differentially to achieve specified performance. A true differential driver or transformer (ac applications) can be used for this purpose. Route the analog inputs tracks (AINP, AINN) as a pair from the buffer to the converter using short, direct tracks and away from digital tracks. A 1-nF to 10-nF capacitor should be used directly across the analog input pins, AINP and AINN. A low-k dielectric (such as COG or film type) should be used to maintain low THD. Capacitors from each analog input to ground can be used. They should be no larger than 1/10 the size of the difference capacitor (typically 100 pF) to preserve the ac common-mode performance.
- Component Placement:** Place the power supply, analog input, and reference input bypass capacitors as close as possible to the device pins. This layout is particularly important for small-value ceramic capacitors. Larger (bulk) decoupling capacitors can be located farther from the device than the smaller ceramic capacitors.

9.2.3 Application Curve

Figure 84 illustrates how the noise of the device, and thus, the SNR, is determined by the mode that is utilized.

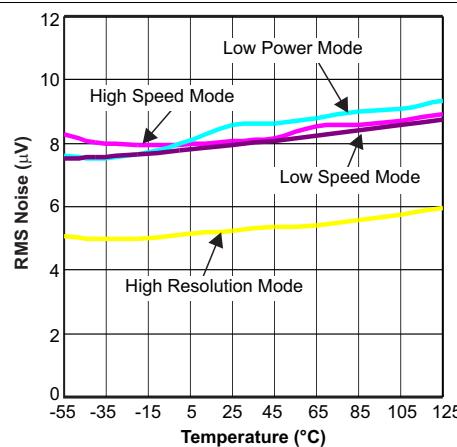


Figure 84. Noise vs Temperature

10 Power Supply Recommendations

The ADS1278-SP has three power supplies: AVDD, DVDD, and IOVDD. AVDD is the analog supply that powers the modulator, DVDD is the digital supply that powers the digital core, and IOVDD is the digital I/O power supply. The IOVDD and DVDD power supplies can be tied together if desired (1.8 V). To achieve rated performance, it is critical that the power supplies are bypassed with 0.1- μ F and 10- μ F capacitors placed as close as possible to the supply pins. A single 10- μ F ceramic capacitor may be substituted in place of the two capacitors.

Figure 85 shows the start-up sequence of the ADS1278-SP. At power-on, bring up the DVDD supply first, followed by IOVDD and then AVDD. Check the power-supply sequence for proper order, including the ramp rate of each supply. DVDD and IOVDD may be sequenced at the same time if the supplies are tied together. Each supply has an internal reset circuit whose outputs are summed together to generate a global power-on reset. After the supplies have exceeded the reset thresholds, 2^{18} f_{CLK} cycles are counted before the converter initiates the conversion process. Following the CLK cycles, the data for 129 conversions are suppressed by the ADS1278-SP to allow output of fully-settled data. In SPI protocol, DRDY is held high during this interval. In frame-sync protocol, DOUT is forced to zero. The power supplies should be applied before any analog or digital pin is driven. For consistent performance, assert SYNC after device power-on when data first appear.

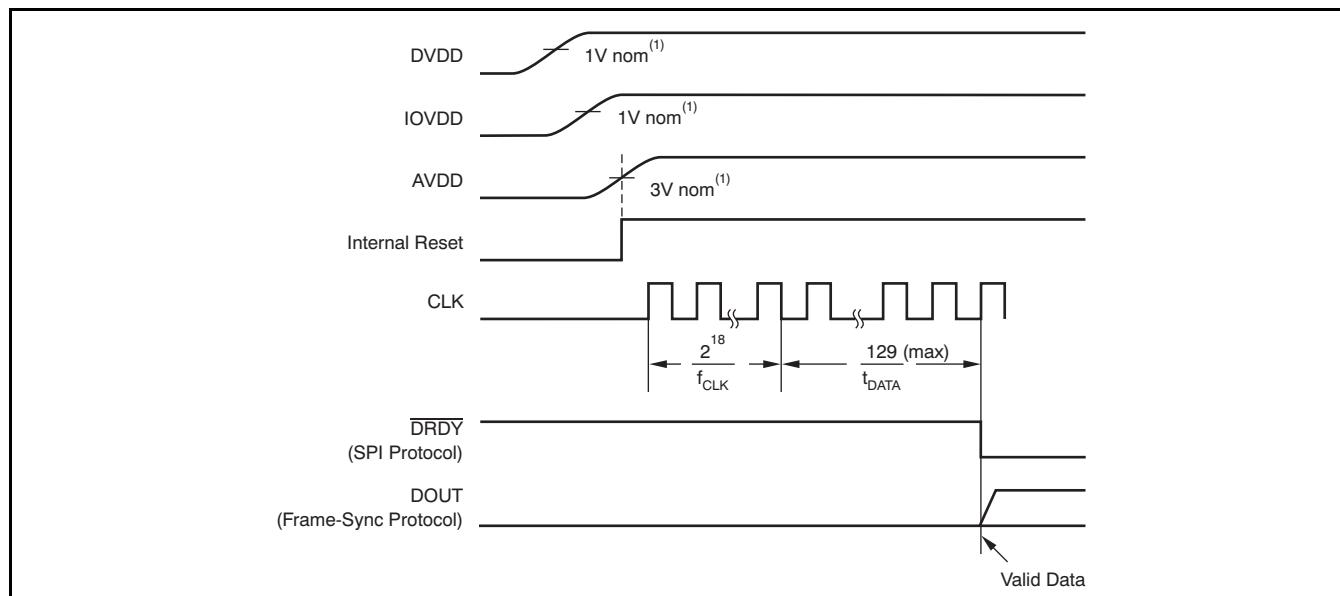


Figure 85. Start-Up Sequence

11 Layout

11.1 Layout Guidelines

In any mixed-signal system design, the power-supply and grounding design plays a significant role. The device distinguishes between two different grounds: AVSS (analog ground) and DGND (digital ground). In low frequency applications such as temperature sensing with thermocouples, laying out the printed circuit board (PCB) to use a single ground plane is adequate but care must be taken so that ground loops are avoided. Ground loops act as loop antennas picking up interference currents which transform into voltage fluctuations. These fluctuations are effectively noise which can degrade system performance in high resolution applications. When placing components and routing over the ground plane, pay close attention to the path that ground currents will take. Avoid having return currents for digital functions pass close to analog sensitive devices or traces.

Additionally, the proximity of digital devices to an analog signal chain has the potential to induce unwanted noise into the system. One primary source of noise is the switching noise from any digital circuitry such as the data output serializer or the microprocessor receiving the data. For the device, care must be taken to ensure that the interaction between the analog and digital supplies within the device is kept to a minimal amount. The extent of noise coupled and transmitted from the digital and analog sections depends on the effective inductances of each of the supply and ground connections. Smaller effective inductances of the supply and ground pins results in better noise suppression. For this reason, multiple pins are used to connect to the digital ground. Low inductance properties must be maintained throughout the design of the PCB layout by use of proper planes and layer thickness.

To avoid noise coupling through supply pins, TI recommends to keep sensitive input pins away from the DVDD and DGND planes. Do not route the traces or vias connected to these pins across these planes; that is, avoid the digital power planes under the analog input pins. Care should be taken to minimize inductance and route digital signals away from analog section.

The analog inputs represent the most sensitive node of the ADC as the total system accuracy depends on the how well the integrity of this signal is maintained. The analog differential inputs to the ADC should be routed tightly coupled and symmetrical for common mode rejection. These inputs should be as short in length as possible to minimize exposure to potential sources of noise.

11.2 Layout Example

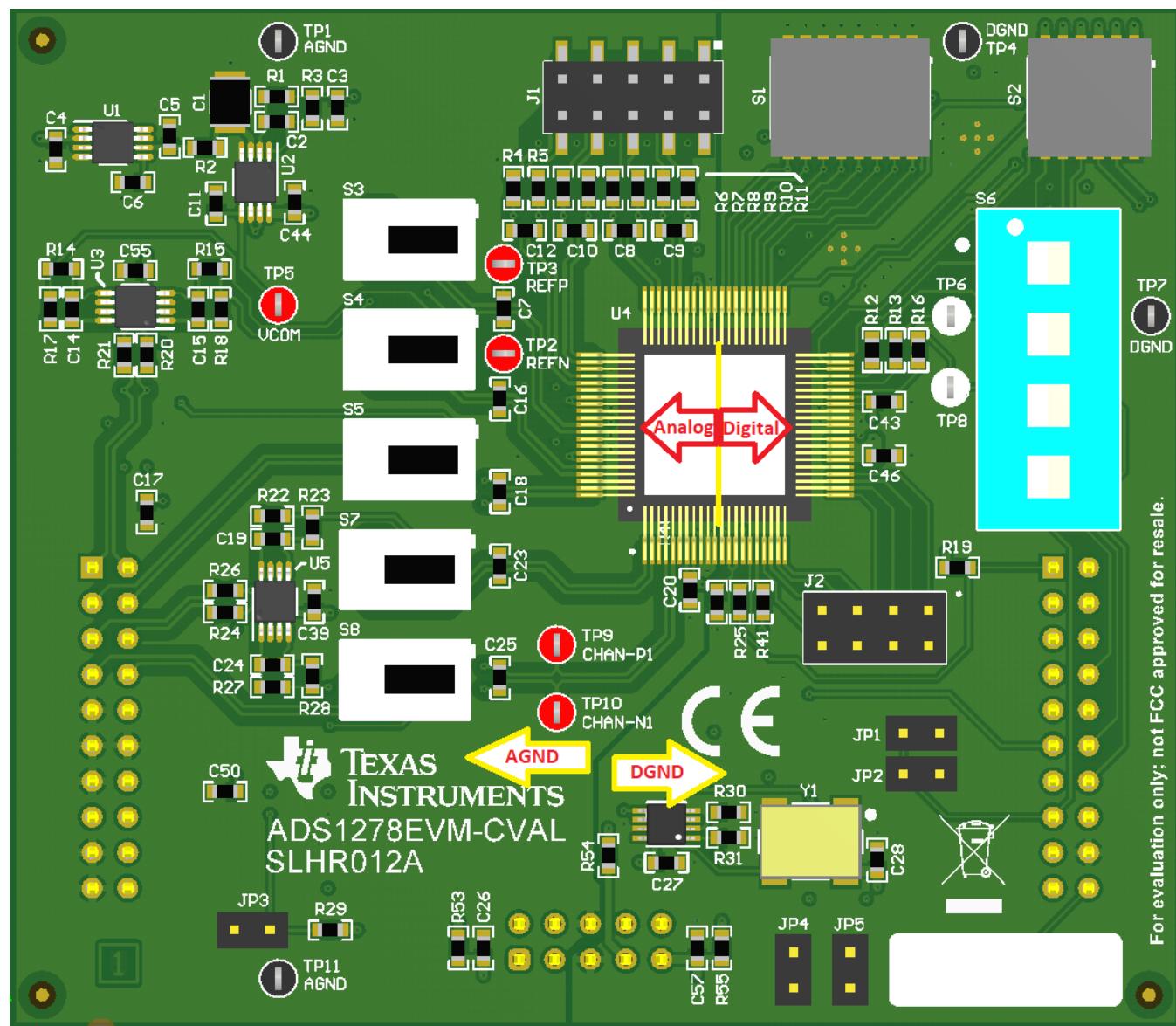


Figure 86. ADS1278-SP Layout Example

12 Device and Documentation Support

12.1 Receiving Notification of Documentation Updates

To receive notification of documentation updates, navigate to the device product folder on ti.com. In the upper right corner, click on *Alert me* to register and receive a weekly digest of any product information that has changed. For change details, review the revision history included in any revised document.

12.2 Community Resources

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TI E2E™ Online Community *TI's Engineer-to-Engineer (E2E) Community*. Created to foster collaboration among engineers. At e2e.ti.com, you can ask questions, share knowledge, explore ideas and help solve problems with fellow engineers.

Design Support *TI's Design Support* Quickly find helpful E2E forums along with design support tools and contact information for technical support.

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 This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

 ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

12.5 Glossary

[SLYZ022](#) — *TI Glossary*.

This glossary lists and explains terms, acronyms, and definitions.

13 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.

PACKAGING INFORMATION

| Orderable part number | Status (1) | Material type (2) | Package Pins | Package qty Carrier | RoHS (3) | Lead finish/ Ball material (4) | MSL rating/ Peak reflow (5) | Op temp (°C) | Part marking (6) |
|-----------------------|---------------|----------------------|----------------|-----------------------|-------------|--------------------------------------|-----------------------------------|--------------|----------------------------|
| ADS1278HFQ/EM | Active | Production | CFP (HFQ) 84 | 1 OTHER | ROHS Exempt | Call TI | Call TI | 25 to 25 | ADS1278HFQ/EM EVAL ONLY |

⁽¹⁾ **Status:** For more details on status, see our [product life cycle](#).

⁽²⁾ **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

⁽³⁾ **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

⁽⁴⁾ **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

⁽⁵⁾ **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

⁽⁶⁾ **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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OTHER QUALIFIED VERSIONS OF ADS1278-SP :

- Catalog : [ADS1278](#)

- Enhanced Product : [ADS1278-EP](#)

NOTE: Qualified Version Definitions:

- Catalog - TI's standard catalog product
- Enhanced Product - Supports Defense, Aerospace and Medical Applications

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